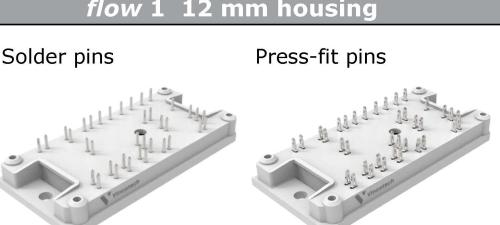
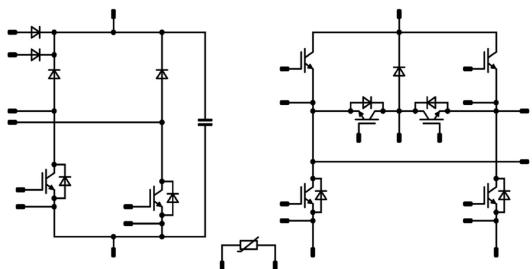




flowSOL 1 BI		650 V / 50 A
Features		flow 1 12 mm housing
<ul style="list-style-type: none">Dual Booster with bypass diode + H6.5 BridgeS5 IGBT Chipset for higher efficiencyKelvin emitter for improved switchingIntegrated DC Link capacitorIntegrated NTCLow inductive design		
Target applications		Schematic
<ul style="list-style-type: none">Power SupplyUPS		
Types		
<ul style="list-style-type: none">10-FY07BVA050S5-LF44E1810-PY07BVA050S5-LF44E18Y		

Maximum Ratings

$T_j = 25^\circ\text{C}$, unless otherwise specified

Parameter	Symbol	Condition	Value	Unit
Low Buck / High Buck Switch				
Collector-emitter voltage	V_{CES}		650	V
Collector current	I_C	$T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$	50	A
Repetitive peak collector current	I_{CRM}	t_p limited by T_{jmax}	150	A
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$	73	W
Gate-emitter voltage	V_{GES}		± 20	V
Maximum junction temperature	T_{jmax}		175	$^\circ\text{C}$



**10-FY07BVA050S5-LF44E18
10-PY07BVA050S5-LF44E18Y**
datasheet

Vincotech

Maximum Ratings

$T_j = 25^\circ\text{C}$, unless otherwise specified

Parameter	Symbol	Condition	Value	Unit
Buck Diode				
Peak repetitive reverse voltage	V_{RRM}		650	V
Continuous (direct) forward current	I_F	$T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$	33	A
Repetitive peak forward current	I_{FRM}	t_p limited by T_{jmax}	60	A
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$	50	W
Maximum junction temperature	T_{jmax}		175	$^\circ\text{C}$
Boost Switch				
Collector-emitter voltage	V_{CES}		650	V
Collector current	I_C	$T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$	50	A
Repetitive peak collector current	I_{CRM}	t_p limited by T_{jmax}	150	A
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$	73	W
Gate-emitter voltage	V_{GES}		± 20	V
Maximum junction temperature	T_{jmax}		175	$^\circ\text{C}$
Low Boost Diode				
Peak repetitive reverse voltage	V_{RRM}		650	V
Continuous (direct) forward current	I_F	$T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$	33	A
Repetitive peak forward current	I_{FRM}	t_p limited by T_{jmax}	60	A
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$	50	W
Maximum junction temperature	T_{jmax}		175	$^\circ\text{C}$
High Boost Diode				
Peak repetitive reverse voltage	V_{RRM}		650	V
Continuous (direct) forward current	I_F	$T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$	33	A
Repetitive peak forward current	I_{FRM}	t_p limited by T_{jmax}	60	A
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$	50	W
Maximum junction temperature	T_{jmax}		175	$^\circ\text{C}$



Vincotech

Maximum Ratings

$T_j = 25^\circ\text{C}$, unless otherwise specified

Parameter	Symbol	Condition	Value	Unit
Input Boost Switch				
Collector-emitter voltage	V_{CES}		650	V
Collector current	I_C	$T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$	50	A
Repetitive peak collector current	I_{CRM}	t_p limited by T_{jmax}	150	A
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$	73	W
Gate-emitter voltage	V_{GES}		± 20	V
Maximum junction temperature	T_{jmax}		175	$^\circ\text{C}$
Input Boost Diode				
Peak repetitive reverse voltage	V_{RRM}		650	V
Continuous (direct) forward current	I_F	$T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$	47	A
Repetitive peak forward current	I_{FRM}	t_p limited by T_{jmax}	100	A
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$	63	W
Maximum junction temperature	T_{jmax}		175	$^\circ\text{C}$
ByPass Diode				
Peak repetitive reverse voltage	V_{RRM}		1600	V
Continuous (direct) forward current	I_F	$T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$	88	A
Surge (non-repetitive) forward current	I_{FSM}	50 Hz Single Half Sine Wave $t_p = 10 \text{ ms}$	600	A
Surge current capability	I_{Ft}		1800	A^2s
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$	105	W
Maximum junction temperature	T_{jmax}		150	$^\circ\text{C}$
Input Boost Sw. Protection Diode				
Peak repetitive reverse voltage	V_{RRM}		650	V
Continuous (direct) forward current	I_F	$T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$	14	A
Repetitive peak forward current	I_{FRM}	t_p limited by T_{jmax}	20	A
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$	33	W
Maximum junction temperature	T_{jmax}		175	$^\circ\text{C}$



10-FY07BVA050S5-LF44E18
10-PY07BVA050S5-LF44E18Y
datasheet

Vincotech

Maximum Ratings

$T_j = 25^\circ\text{C}$, unless otherwise specified

Parameter	Symbol	Condition	Value	Unit
Capacitor (DC)				
Maximum DC voltage	V_{MAX}		630	V
Operation Temperature	T_{op}		-55...+125	°C

Module Properties

Thermal Properties

Storage temperature	T_{stg}		-40...+125	°C
Operation temperature under switching condition	T_{op}		-40...($T_{\text{jmax}} - 25$)	°C

Isolation Properties

Isolation voltage	V_{isol}	DC Test Voltage*	$t_p = 2 \text{ s}$	6000	V
		AC Voltage	$t_p = 1 \text{ min}$	2500	V
Creepage distance				min. 12,7	mm
Clearance		Solder pins / Press-fit pins		8,16 / 7,93	mm
Comparative Tracking Index	CTI			> 200	

*100 % tested in production



**10-FY07BVA050S5-LF44E18
10-PY07BVA050S5-LF44E18Y**
datasheet

Vincotech

Characteristic Values

Parameter	Symbol	Conditions						Value			Unit
			V_{GE} [V]	V_{CE} [V]	I_c [A]	I_D [A]	T_1 [°C]	Min	Typ	Max	
			V_{GS} [V]	V_{DS} [V]	I_F [A]						

Low Buck / High Buck Switch

Static

Gate-emitter threshold voltage	$V_{GE(th)}$	$V_{GE} = V_{CE}$			0,0005	25	3,2	4	4,8	V
Collector-emitter saturation voltage	V_{CEsat}		15		50	125 150		1,35 1,41 1,43	1,75	V
Collector-emitter cut-off current	I_{CES}		0	650		25			50	µA
Gate-emitter leakage current	I_{GES}		20	0		25			100	nA
Internal gate resistance	r_g							none		Ω
Input capacitance	C_{ies}	$f = 1 \text{ Mhz}$	0	25	25	25		3100		pF
Reverse transfer capacitance	C_{res}							12		
Gate charge	Q_g		15	650	50	25		120		

Thermal

Thermal resistance junction to sink	$R_{th(j-s)}$	$\lambda_{\text{paste}} = 3,4 \text{ W/mK}$ (PSX)						1,29		K/W
-------------------------------------	---------------	--	--	--	--	--	--	------	--	-----

Dynamic

Turn-on delay time	$t_{d(on)}$	$R_{gon} = 8 \Omega$ $R_{goff} = 8 \Omega$	± 15	350	50	25		64		ns
Rise time	t_r					125		65		
						150		66		
Turn-off delay time	$t_{d(off)}$					25		8		
						125		10		
Fall time	t_f					150		10		
						25		81		
Turn-on energy (per pulse)	E_{on}					125		95		
						150		99		
Turn-off energy (per pulse)	E_{off}					25		12		mWs
						125		20		
						150		23		
						25		0,689		mWs
						125		0,887		
						150		0,874		
						25		0,456		mWs
						125		0,732		
						150		0,764		



10-FY07BVA050S5-LF44E18
10-PY07BVA050S5-LF44E18Y
datasheet

Vincotech

Characteristic Values

Parameter	Symbol	Conditions						Value			Unit		
			V_{GE} [V]	V_{CE} [V]	I_c [A]	V_{GS} [V]	V_{DS} [V]	I_D [A]	T_1 [°C]	I_F [A]	Min	Typ	Max

Buck Diode

Static

Forward voltage	V_F				30	25 125 150			1,52 1,46 1,44	1,92	V
Reverse leakage current	I_R			650		25				1,6	µA

Thermal

Thermal resistance junction to sink	$R_{th(j-s)}$	$\lambda_{paste} = 3,4 \text{ W/mK}$ (PSX)							1,92		K/W
-------------------------------------	---------------	---	--	--	--	--	--	--	------	--	-----

Dynamic

Peak recovery current	I_{RRM}	$di/dt = 6812 \text{ A/}\mu\text{s}$ $di/dt = 5829 \text{ A/}\mu\text{s}$ $di/dt = 5655 \text{ A/}\mu\text{s}$	± 15	350	50	25		70			A
Reverse recovery time	t_{rr}					125		77			
						150		78			
Recovered charge	Q_r					25		59			ns
						125		100			
Recovered charge	Q_r					150		111			
Recovered charge	Q_r					25		2,25			µC
Reverse recovered energy	E_{rec}					125		3,43			
						150		3,88			
Reverse recovered energy	E_{rec}					25		0,608			mWs
						125		0,922			
Peak rate of fall of recovery current	$(di_{rf}/dt)_{max}$					150		1,04			
Peak rate of fall of recovery current	$(di_{rf}/dt)_{max}$					25		5343			A/µs
						125		4706			
						150		4865			



Vincotech

Characteristic Values

Parameter	Symbol	Conditions						Value			Unit
			V_{GE} [V]	V_{CE} [V]	I_c [A]	I_D [A]	T_1 [°C]	Min	Typ	Max	
			V_{GS} [V]	V_{DS} [V]	I_F [A]						

Boost Switch

Static

Gate-emitter threshold voltage	$V_{GE(th)}$	$V_{GE} = V_{CE}$			0,0005	25	3,2	4	4,8	V
Collector-emitter saturation voltage	V_{CESat}		15		50	125 150		1,35 1,41 1,43	1,75	V
Collector-emitter cut-off current	I_{CES}		0	650		25			50	µA
Gate-emitter leakage current	I_{GES}		20	0		25			100	nA
Internal gate resistance	r_g							none		Ω
Input capacitance	C_{ies}	$f = 1 \text{ Mhz}$	0	25	25	25		3100		pF
Reverse transfer capacitance	C_{res}							12		
Gate charge	Q_g		15	650	50	25		120		

Thermal

Thermal resistance junction to sink	$R_{th(j-s)}$	$\lambda_{\text{paste}} = 3,4 \text{ W/mK}$ (PSX)						1,29		K/W
-------------------------------------	---------------	--	--	--	--	--	--	------	--	-----

Dynamic (T21-D12)

Turn-on delay time	$t_{d(on)}$	$R_{gon} = 8 \Omega$ $R_{goff} = 8 \Omega$	± 15	350	50	25		65		ns
Rise time	t_r					125		65		
						150		66		
Turn-off delay time	$t_{d(off)}$					25		11		
						125		12		
Fall time	t_f					150		11		
Turn-on energy (per pulse)	E_{on}	$Q_{rFWD} = 1,5 \mu\text{C}$ $Q_{rFWD} = 2,5 \mu\text{C}$ $Q_{rFWD} = 2,9 \mu\text{C}$				25		80		mWs
						125		96		
						150		101		
Turn-off energy (per pulse)	E_{off}					25		11		
						125		20		
						150		24		
						25		0,429		
						125		0,578		
						150		0,650		
						25		0,450		
						125		0,714		
						150		0,787		



10-FY07BVA050S5-LF44E18
10-PY07BVA050S5-LF44E18Y
datasheet

Vincotech

Characteristic Values

Parameter	Symbol	Conditions						Value			Unit
			V_{GE} [V]	V_{CE} [V]	I_c [A]	I_D [A]	T_1 [°C]	Min	Typ	Max	
			V_{GS} [V]	V_{DS} [V]	I_F [A]						

Low Boost Diode

Static

Forward voltage	V_F				30	25 125 150		1,52 1,46 1,44	1,92		V
Reverse leakage current	I_R			650		25			1,6		µA

Thermal

Thermal resistance junction to sink	$R_{th(j-s)}$	$\lambda_{paste} = 3,4 \text{ W/mK}$ (PSX)						1,92		K/W
-------------------------------------	---------------	---	--	--	--	--	--	------	--	-----

Dynamic (T21-D12)

Peak recovery current	I_{RRM}	$di/dt = 5070 \text{ A/}\mu\text{s}$ $di/dt = 3762 \text{ A/}\mu\text{s}$ $di/dt = 3712 \text{ A/}\mu\text{s}$	± 15	350	50	25		48		A
Reverse recovery time	t_{rr}					125		57		
						150		60		
Recovered charge	Q_r					25		63		ns
						125		102		
Reverse recovered energy	E_{rec}					150		113		
						25		1,47		
Peak rate of fall of recovery current	$(di_{rf}/dt)_{max}$					125		2,52		µC
						150		2,87		
						25		0,423		
						125		0,686		mWs
						150		0,779		
						25		2718		
						125		739		A/µs
						150		888		



**10-FY07BVA050S5-LF44E18
10-PY07BVA050S5-LF44E18Y**
datasheet

Vincotech

Characteristic Values

Parameter	Symbol	Conditions						Value			Unit
			V_{GE} [V]	V_{CE} [V]	I_c [A]	I_D [A]	T_1 [°C]	Min	Typ	Max	
			V_{GS} [V]	V_{DS} [V]	I_F [A]						

Boost Switch

Static

Gate-emitter threshold voltage	$V_{GE(th)}$	$V_{GE} = V_{CE}$			0,0005	25	3,2	4	4,8	V
Collector-emitter saturation voltage	V_{CEsat}		15		50	125 150		1,35 1,41 1,43	1,75	V
Collector-emitter cut-off current	I_{CES}		0	650		25			50	µA
Gate-emitter leakage current	I_{GES}		20	0		25			100	nA
Internal gate resistance	r_g							none		Ω
Input capacitance	C_{ies}	$f = 1 \text{ Mhz}$	0	25	25	25		3100		pF
Reverse transfer capacitance	C_{res}							12		
Gate charge	Q_g		15	650	50	25		120		

Thermal

Thermal resistance junction to sink	$R_{th(j-s)}$	$\lambda_{\text{paste}} = 3,4 \text{ W/mK}$ (PSX)						1,29		K/W
-------------------------------------	---------------	--	--	--	--	--	--	------	--	-----

Dynamic (T21-D20)

Turn-on delay time	$t_{d(on)}$	$R_{gon} = 8 \Omega$ $R_{goff} = 8 \Omega$	± 15	350	50	25		61		ns
Rise time	t_r					125		66		
						150		66		
Turn-off delay time	$t_{d(off)}$					25		9		
						125		11		
Fall time	t_f					150		11		
						25		79		
Turn-on energy (per pulse)	E_{on}					125		96		
						150		100		
Turn-off energy (per pulse)	E_{off}					25		9		
						125		19		
						150		23		
						25		0,493		mWs
						125		0,568		
						150		0,556		
						25		0,362		
						125		0,688		
						150		0,784		



Characteristic Values

Parameter	Symbol	Conditions						Value			Unit
			V_{GE} [V]	V_{CE} [V]	I_c [A]	I_D [A]	T_1 [°C]	Min	Typ	Max	
			V_{GS} [V]	V_{DS} [V]	I_F [A]						

High Boost Diode

Static

Forward voltage	V_F				30	25 125 150		1,52 1,46 1,44	1,92		V
Reverse leakage current	I_R			650		25			1,6		µA

Thermal

Thermal resistance junction to sink	$R_{th(j-s)}$	$\lambda_{paste} = 3,4 \text{ W/mK}$ (PSX)						1,92		K/W
-------------------------------------	---------------	---	--	--	--	--	--	------	--	-----

Dynamic (T21-D20)

Peak recovery current	I_{RRM}	$di/dt = 4573 \text{ A/}\mu\text{s}$ $di/dt = 4041 \text{ A/}\mu\text{s}$ $di/dt = 4075 \text{ A/}\mu\text{s}$	± 15	350	50	25		52		A
Reverse recovery time	t_{rr}					125		59		
Recovered charge	Q_r					150		63		
Recovered charge	Q_r	$di/dt = 4573 \text{ A/}\mu\text{s}$ $di/dt = 4041 \text{ A/}\mu\text{s}$ $di/dt = 4075 \text{ A/}\mu\text{s}$	± 15	350	50	25		60		ns
Reverse recovered energy	E_{rec}					125		105		
Reverse recovered energy	E_{rec}					150		115		
Peak rate of fall of recovery current	$(di_{rf}/dt)_{max}$	$di/dt = 4573 \text{ A/}\mu\text{s}$ $di/dt = 4041 \text{ A/}\mu\text{s}$ $di/dt = 4075 \text{ A/}\mu\text{s}$	± 15	350	50	25		1,444		µC
Peak rate of fall of recovery current	$(di_{rf}/dt)_{max}$					125		2,475		
Peak rate of fall of recovery current	$(di_{rf}/dt)_{max}$					150		2,932		
Reverse recovered energy	E_{rec}	$di/dt = 4573 \text{ A/}\mu\text{s}$ $di/dt = 4041 \text{ A/}\mu\text{s}$ $di/dt = 4075 \text{ A/}\mu\text{s}$	± 15	350	50	25		0,362		mWs
Reverse recovered energy	E_{rec}					125		0,682		
Reverse recovered energy	E_{rec}					150		0,811		
Peak rate of fall of recovery current	$(di_{rf}/dt)_{max}$	$di/dt = 4573 \text{ A/}\mu\text{s}$ $di/dt = 4041 \text{ A/}\mu\text{s}$ $di/dt = 4075 \text{ A/}\mu\text{s}$	± 15	350	50	25		3629		A/µs
Peak rate of fall of recovery current	$(di_{rf}/dt)_{max}$					125		771		
Peak rate of fall of recovery current	$(di_{rf}/dt)_{max}$					150		814		



**10-FY07BVA050S5-LF44E18
10-PY07BVA050S5-LF44E18Y**
datasheet

Vincotech

Characteristic Values

Parameter	Symbol	Conditions						Value			Unit
			V_{GE} [V]	V_{CE} [V]	I_c [A]	I_D [A]	T_1 [°C]	Min	Typ	Max	
			V_{GS} [V]	V_{DS} [V]	I_F [A]						

Input Boost Switch

Static

Gate-emitter threshold voltage	$V_{GE(th)}$	$V_{GE} = V_{CE}$			0,0005	25	3,2	4	4,8	V
Collector-emitter saturation voltage	V_{CEsat}		15		50	125 150		1,35 1,41 1,43	1,75	V
Collector-emitter cut-off current	I_{CES}		0	650		25			50	µA
Gate-emitter leakage current	I_{GES}		20	0		25			100	nA
Internal gate resistance	r_g							none		Ω
Input capacitance	C_{ies}	$f = 1 \text{ Mhz}$	0	25	25	25		3100		pF
Reverse transfer capacitance	C_{res}							12		
Gate charge	Q_g		15	650	50	25		120		

Thermal

Thermal resistance junction to sink	$R_{th(j-s)}$	$\lambda_{paste} = 3,4 \text{ W/mK}$ (PSX)						1,29		K/W
-------------------------------------	---------------	---	--	--	--	--	--	------	--	-----

Dynamic

Turn-on delay time	$t_{d(on)}$	$R_{gon} = 8 \Omega$ $R_{goff} = 8 \Omega$	0 / 15	400	50	25		26		ns
Rise time	t_r					125 150		25	9	
Turn-off delay time	$t_{d(off)}$					125 150		125 150	10 11	
Fall time	t_f					125 150		137 156 160		
Turn-on energy (per pulse)	E_{on}					125 150		12 17 21		
Turn-off energy (per pulse)	E_{off}					125 150		1,07 1,48 1,37		



Vincotech

Characteristic Values

Parameter	Symbol	Conditions						Value			Unit
			V_{GE} [V] V_{GS} [V]	V_{CE} [V] V_{DS} [V] V_r [V]	I_c [A] I_D [A] I_F [A]	T_j [°C]	Min	Typ	Max		

Input Boost Diode

Static

Forward voltage	V_F				50	25 125 150		1,50 1,44 1,42	1,92		V
Reverse leakage current	I_R			650		25			2,65		µA

Thermal

Thermal resistance junction to sink	$R_{th(j-s)}$	$\lambda_{paste} = 3,4 \text{ W/mK}$ (PSX)						1,50		K/W
-------------------------------------	---------------	---	--	--	--	--	--	------	--	-----

Dynamic

Peak recovery current	I_{RRM}	$di/dt = 6127 \text{ A/}\mu\text{s}$ $di/dt = 5448 \text{ A/}\mu\text{s}$ $di/dt = 5124 \text{ A/}\mu\text{s}$	0 / 15	400	50	25		47		A
Reverse recovery time	t_{rr}					125		63		
Recovered charge	Q_r					150		66		
Reverse recovered energy	E_{rec}					25		58		
Peak rate of fall of recovery current	$(di_{rf}/dt)_{max}$					125		91		ns
						150		98		
						25		1,61		
						125		3,20		
						150		3,61		µC
						25		0,424		
						125		0,884		mWs
						150		0,993		
						25		564		
						125		642		
						150		635		A/µs

ByPass Diode

Static

Forward voltage	V_F				65	25 125 150		1,14 1,09 1,08		V	
Reverse leakage current	I_R			1600		25			50		µA

Thermal

Thermal resistance junction to sink	$R_{th(j-s)}$	$\lambda_{paste} = 3,4 \text{ W/mK}$ (PSX)						0,67		K/W
-------------------------------------	---------------	---	--	--	--	--	--	------	--	-----



Vincotech

Characteristic Values

Parameter	Symbol	Conditions						Value			Unit
		V_{GE} [V]	V_{CE} [V]	I_c [A]	I_D [A]	T_j [°C]	Min	Typ	Max		
		V_{GS} [V]	V_{DS} [V]	I_F [A]							

Input Boost Sw. Protection Diode

Static

Forward voltage	V_F			10	25	125		1,67 1,56	1,87	V
Reverse leakage current	I_R		650		25			0,14	μA	

Thermal

Thermal resistance junction to sink	$R_{th(j-s)}$	$\lambda_{paste} = 3,4 \text{ W/mK}$ (PSX)						2,87		K/W
-------------------------------------	---------------	---	--	--	--	--	--	------	--	-----

Capacitor (DC)

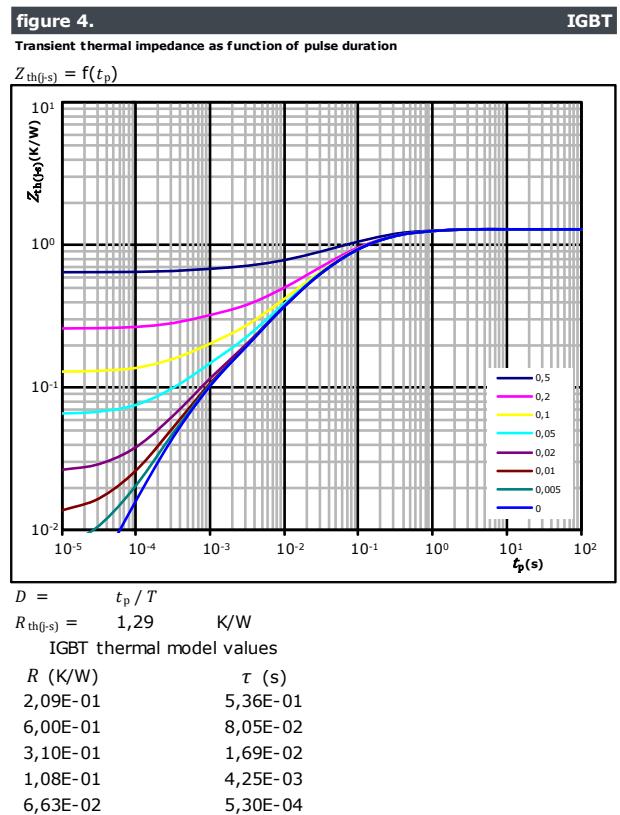
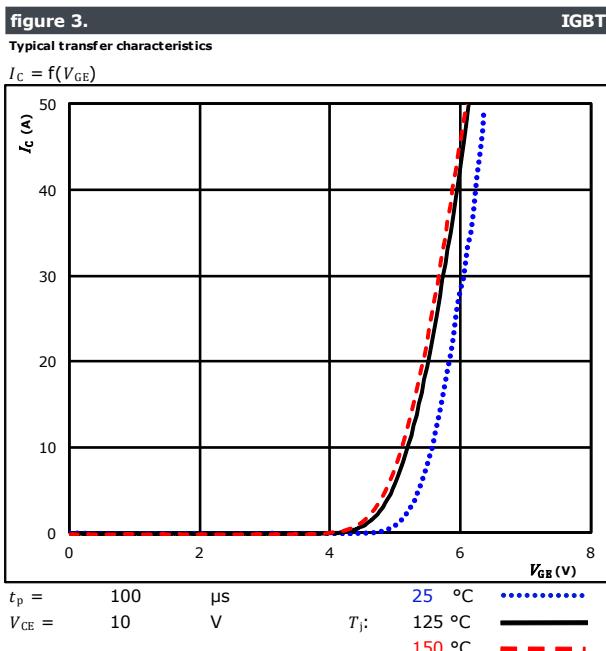
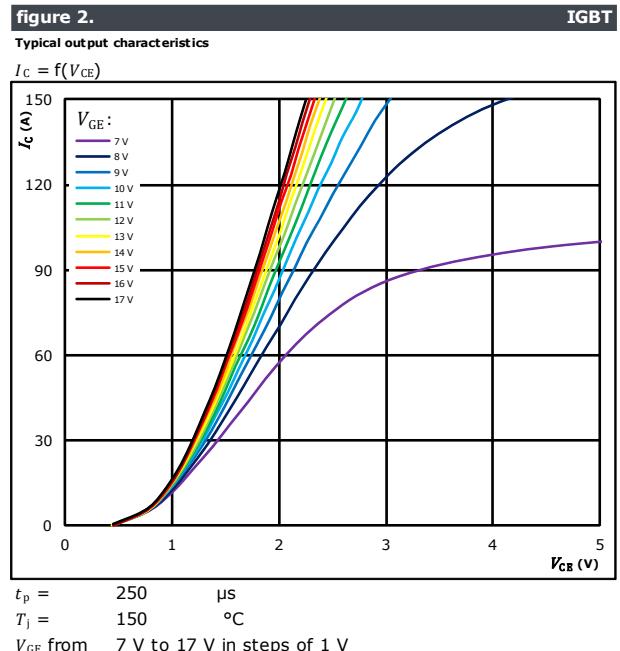
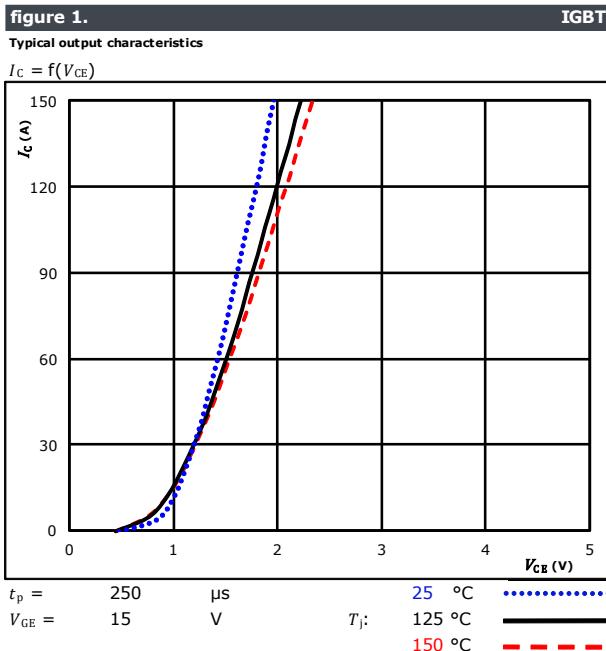
Capacitance	C						100		nF
Tolerance						-10		+10	%
Dissipation factor								2,5	%

Thermistor

Rated resistance	R				25		22		kΩ
Deviation of R_{100}	$\Delta_{R/R}$	$R_{100} = 1484 \Omega$			100	-5		5	%
Power dissipation	P				25		5		mW
Power dissipation constant					25		1,5		mW/K
B-value	$B_{(25/50)}$	Tol. ±1 %			25		3962		K
B-value	$B_{(25/100)}$	Tol. ±1 %			25		4000		K
Vincotech NTC Reference								I	



Low Buck / High Buck Switch Characteristics





Vincotech

**10-FY07BVA050S5-LF44E18
10-PY07BVA050S5-LF44E18Y**
datasheet

Low Buck / High Buck Switch Characteristics

figure 5.

Gate voltage vs gate charge

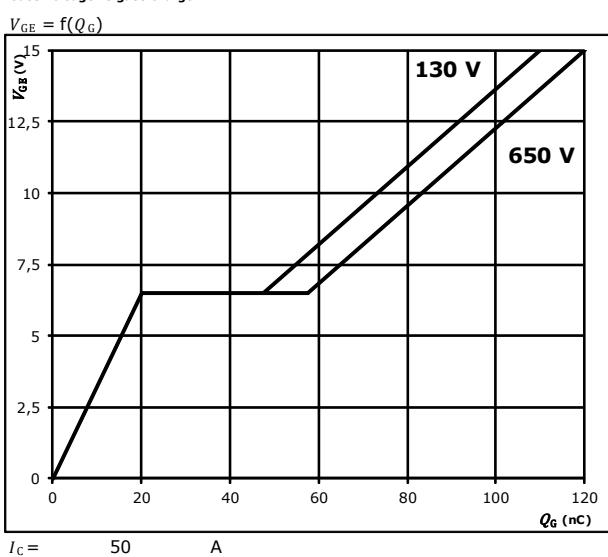
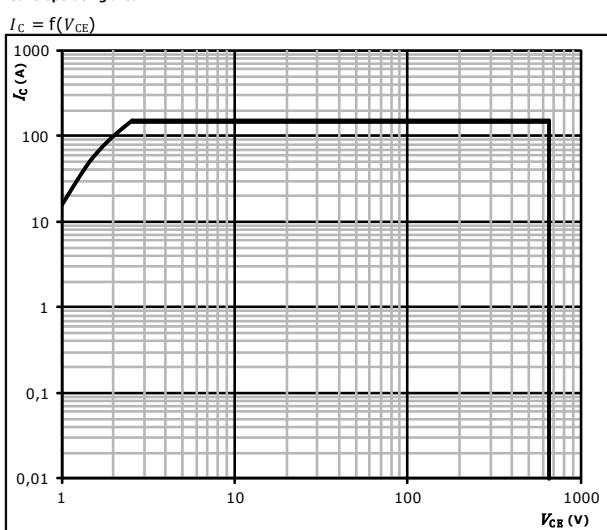


figure 6.

Safe operating area



D = single pulse

T_s = 80 °C

V_{GE} = ±15 V

T_j = T_{jmax}



Vincotech

**10-FY07BVA050S5-LF44E18
10-PY07BVA050S5-LF44E18Y**
datasheet

Buck Diode Characteristics

figure 1. FWD

Typical forward characteristics

$$I_F = f(V_F)$$

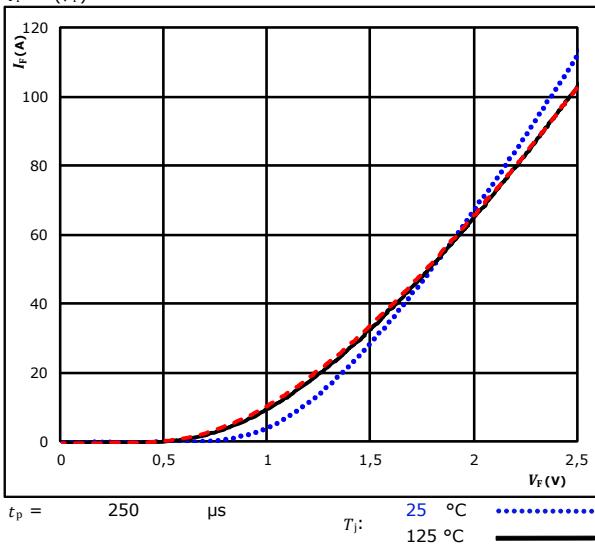
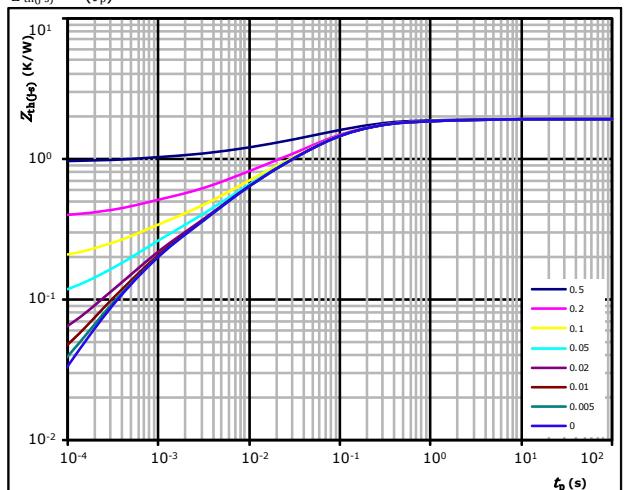


figure 2. FWD

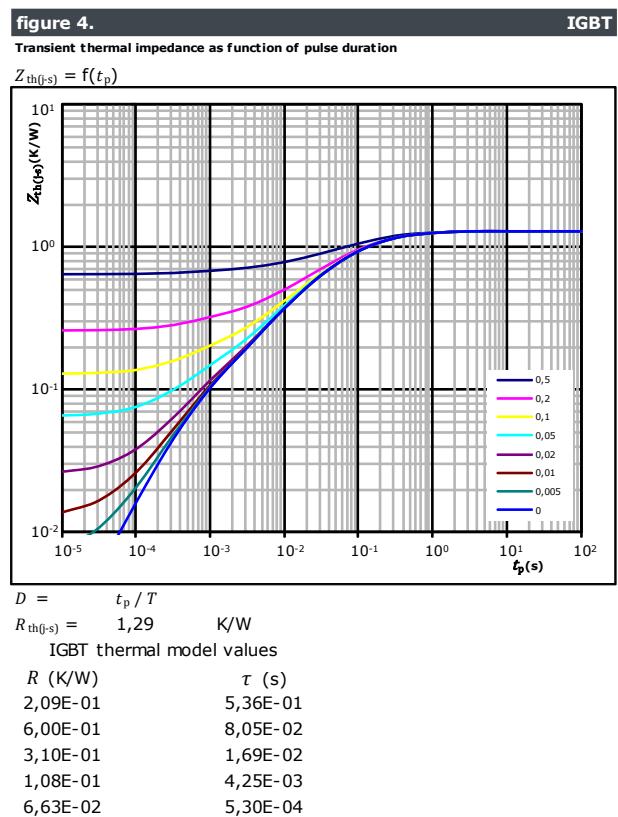
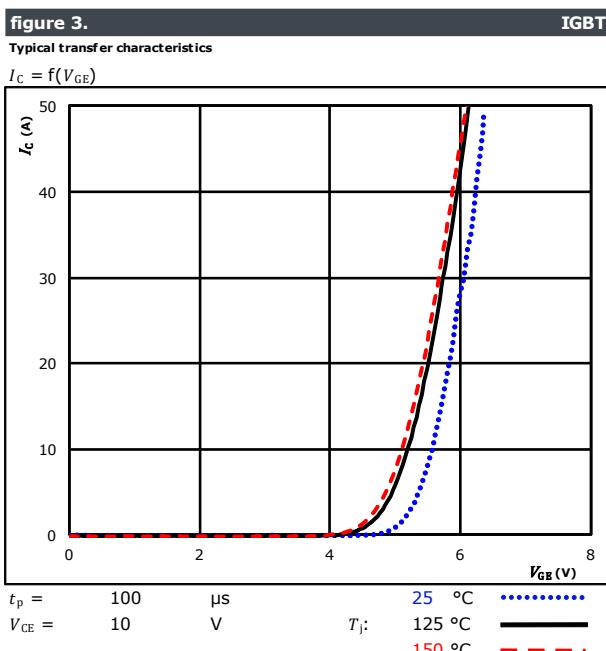
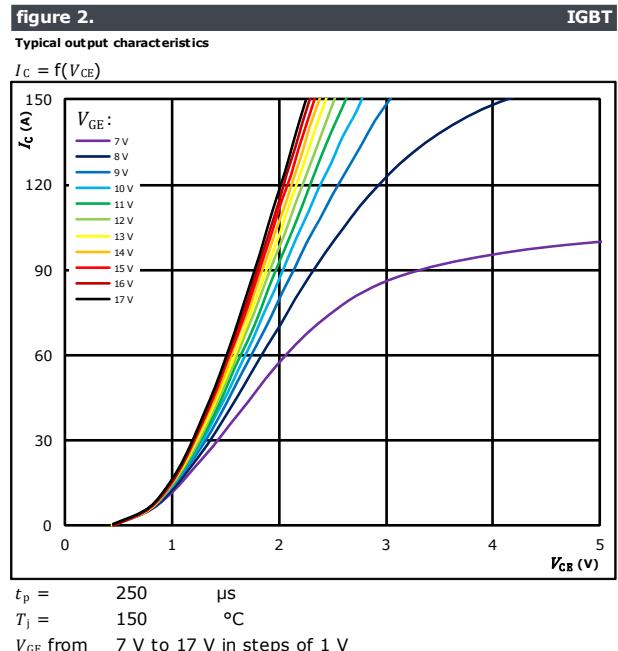
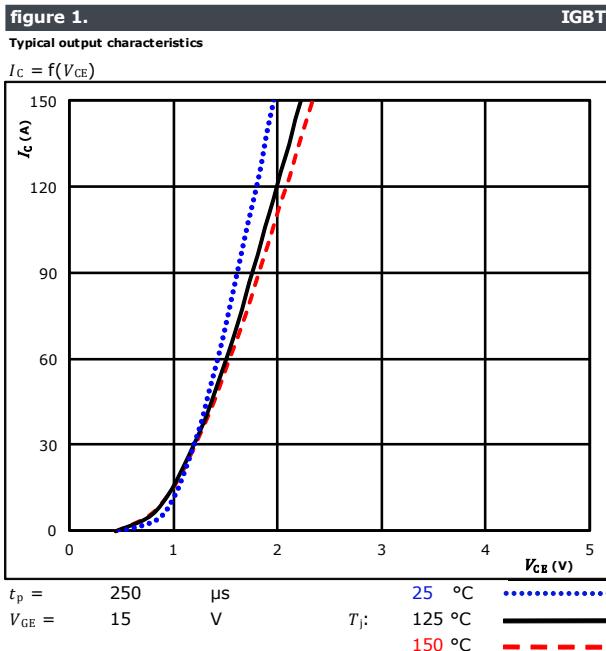
Transient thermal impedance as a function of pulse width

$$Z_{\text{th}(t_p)} = f(t_p)$$





Boost Switch Characteristics

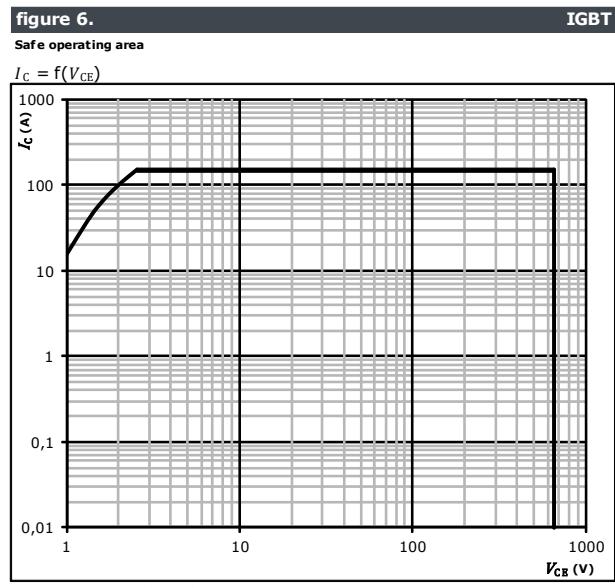
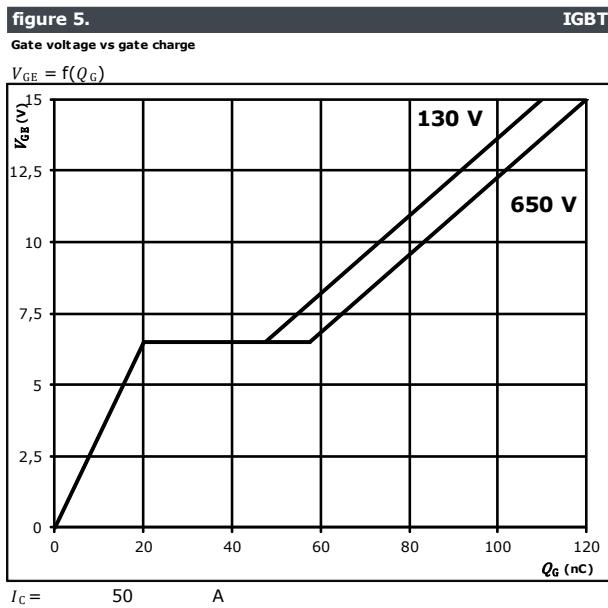




Vincotech

**10-FY07BVA050S5-LF44E18
10-PY07BVA050S5-LF44E18Y**
datasheet

Boost Switch Characteristics



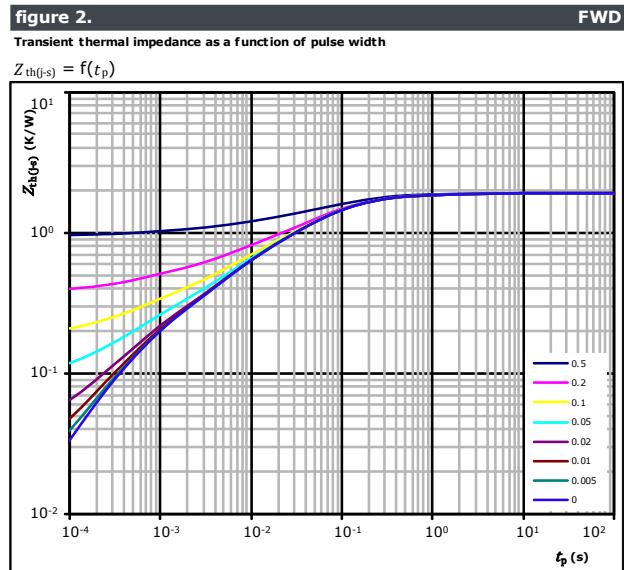
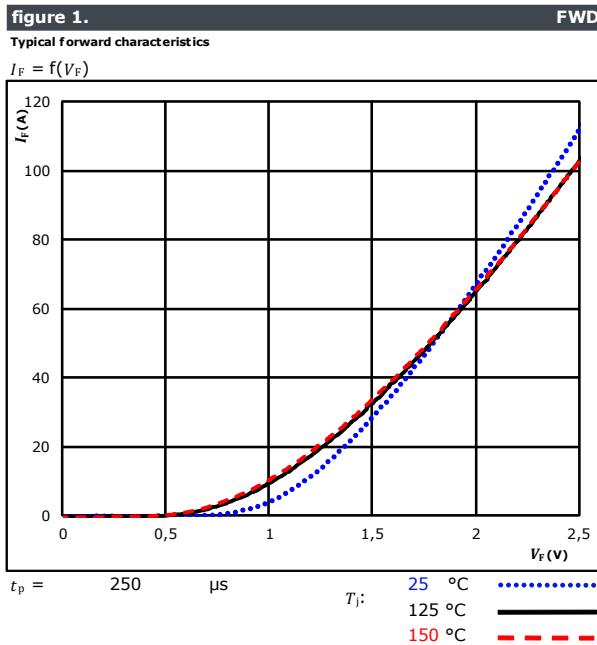
D = single pulse
 T_s = 80 °C
 V_{GE} = ±15 V
 T_j = T_{jmax}



**10-FY07BVA050S5-LF44E18
10-PY07BVA050S5-LF44E18Y**
datasheet

Vincotech

Low / High Boost Diode Characteristics

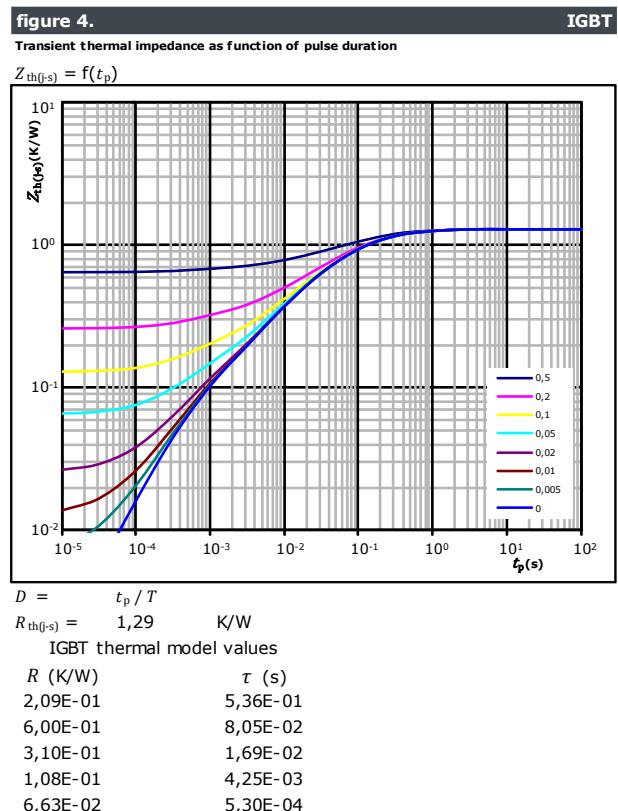
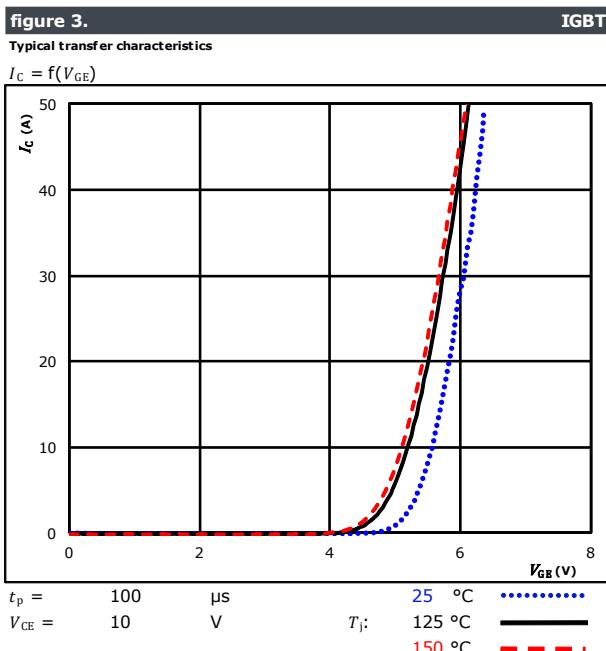
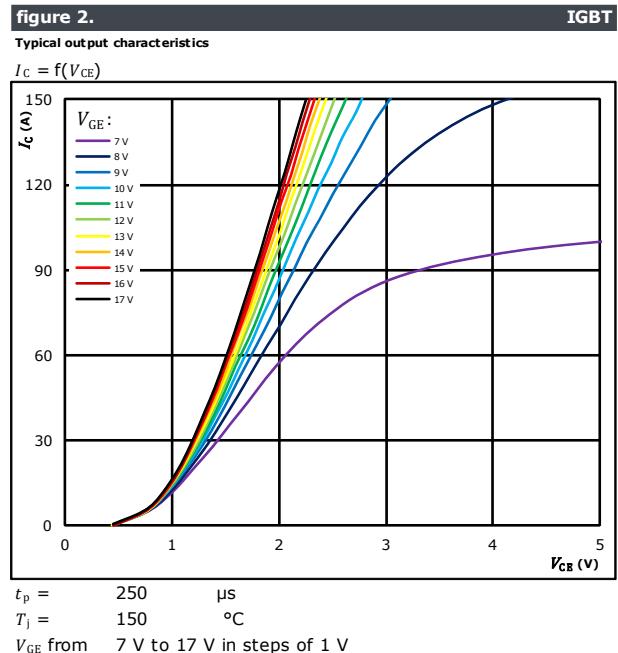
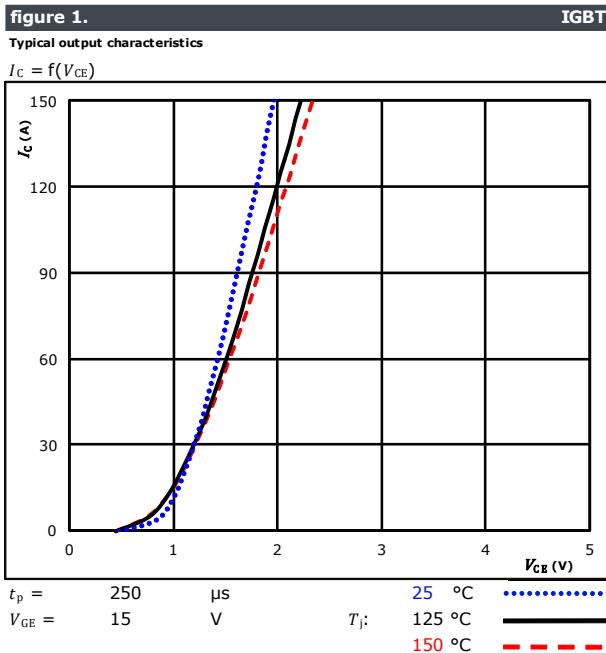




**10-FY07BVA050S5-LF44E18
10-PY07BVA050S5-LF44E18Y**
datasheet

Vincotech

Input Boost Switch Characteristics





Vincotech

**10-FY07BVA050S5-LF44E18
10-PY07BVA050S5-LF44E18Y**
datasheet

Input Boost Switch Characteristics

figure 5.

Gate voltage vs gate charge

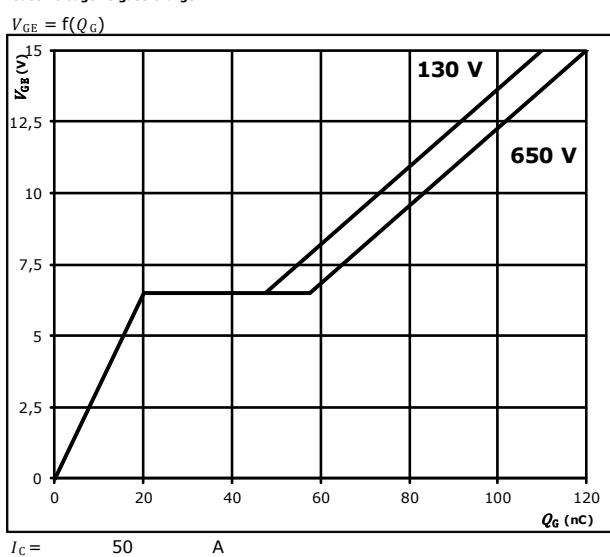
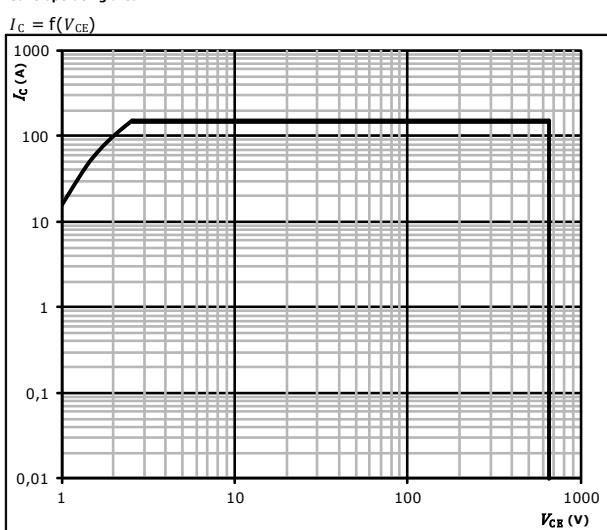


figure 6.

Safe operating area



D = single pulse

T_s = 80 °C

V_{GE} = ±15 V

T_j = T_{jmax}



Vincotech

**10-FY07BVA050S5-LF44E18
10-PY07BVA050S5-LF44E18Y**
datasheet

Input Boost Diode Characteristics

figure 1.

FWD

Typical forward characteristics

$$I_F = f(V_F)$$

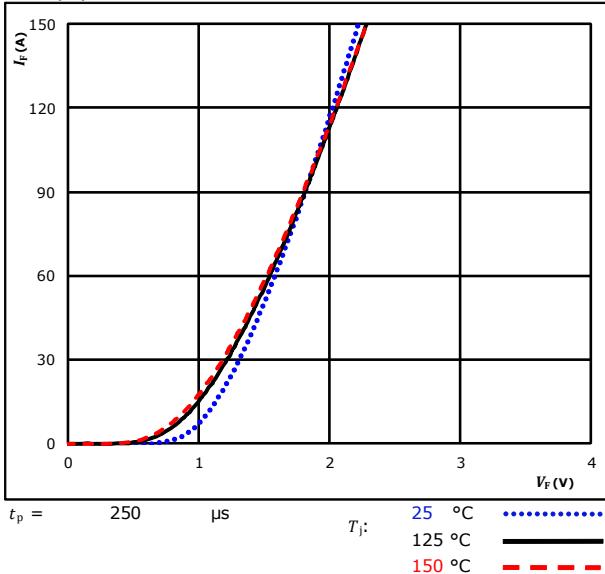
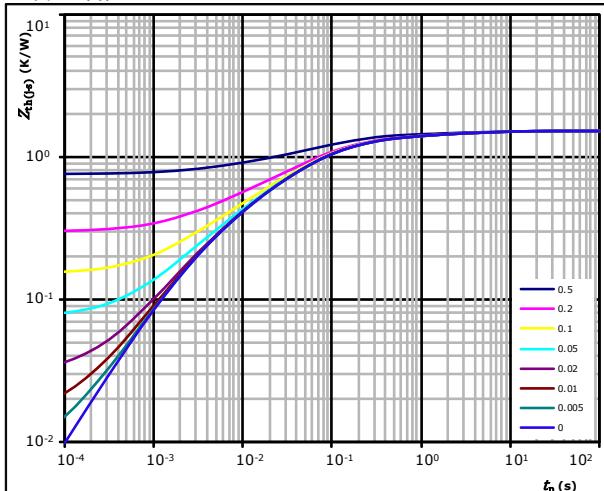


figure 2.

FWD

Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$



$$D = t_p / T$$

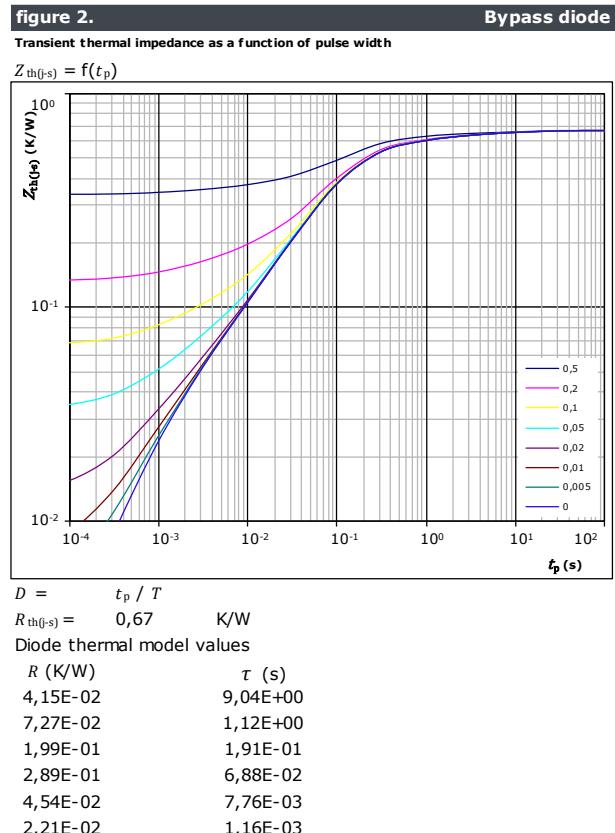
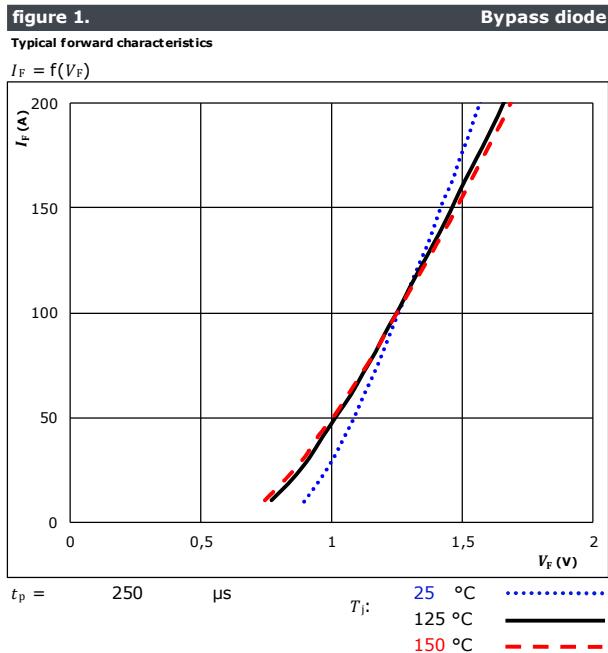
$$R_{th(j-s)} = 1,50 \text{ K/W}$$

FWD thermal model values

R (K/W)	τ (s)
1,03E-01	4,73E+00
2,05E-01	5,53E-01
6,39E-01	8,31E-02
3,39E-01	2,02E-02
1,71E-01	4,42E-03
4,45E-02	1,30E-03



ByPass Diode Characteristics

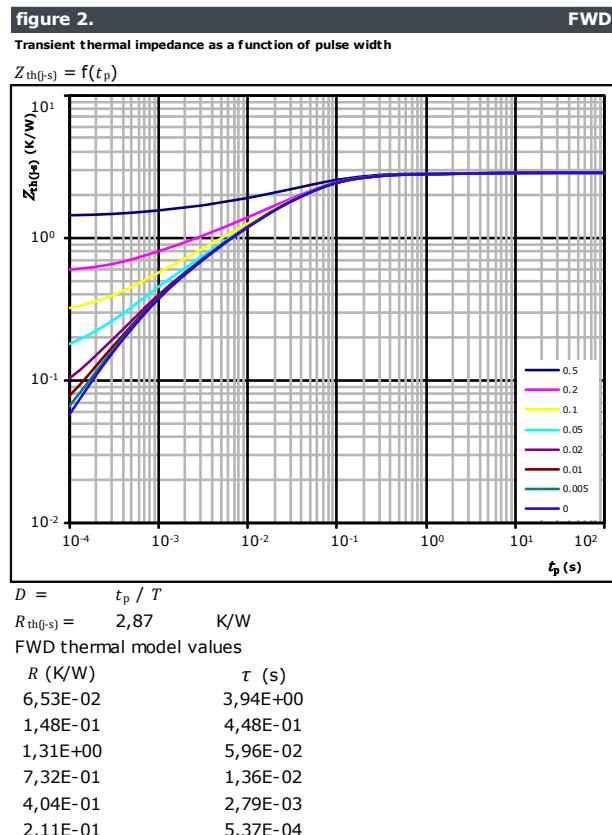
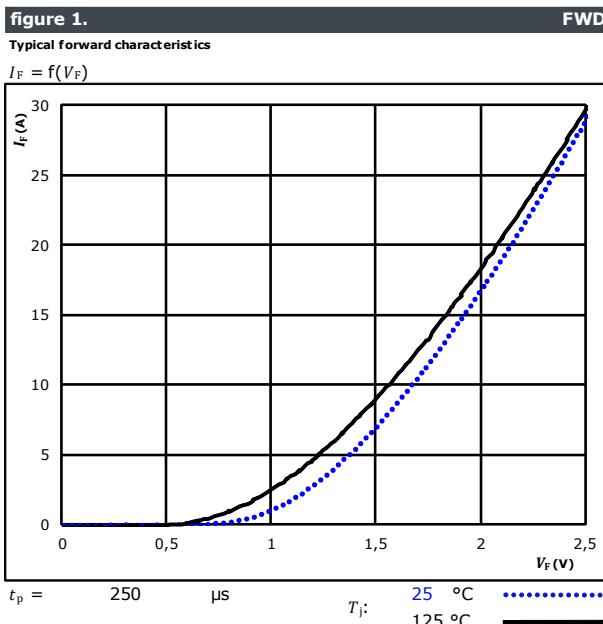




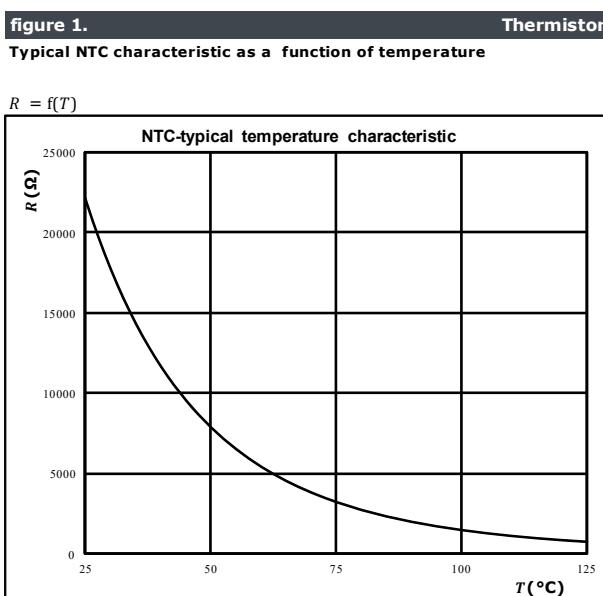
Vincotech

**10-FY07BVA050S5-LF44E18
10-PY07BVA050S5-LF44E18Y**
datasheet

Input Boost Sw. Protection Diode Characteristics



Thermistor Characteristics





Vincotech

Low Buck / High Buck Switching Characteristics

figure 1. IGBT

Typical switching energy losses as a function of collector current

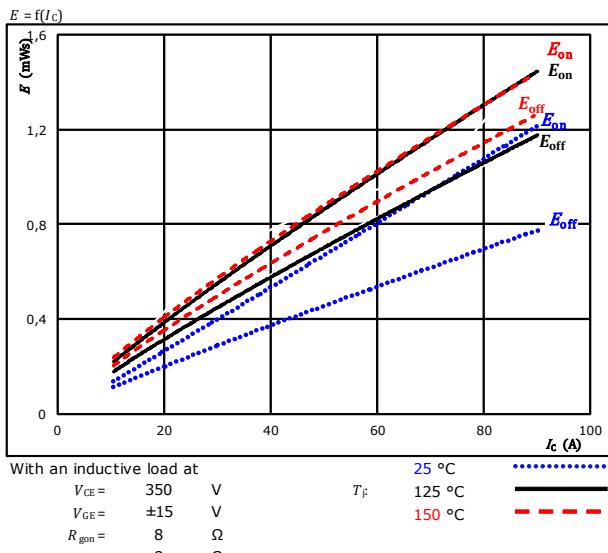


figure 2. IGBT

Typical switching energy losses as a function of gate resistor

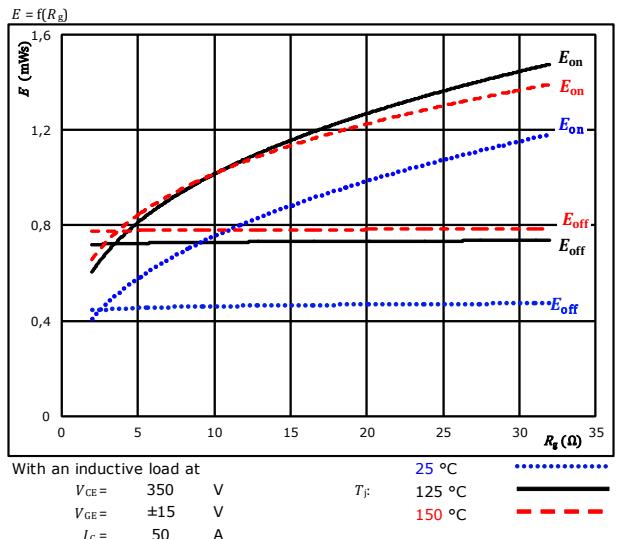


figure 3. FWD

Typical reverse recovered energy loss as a function of collector current

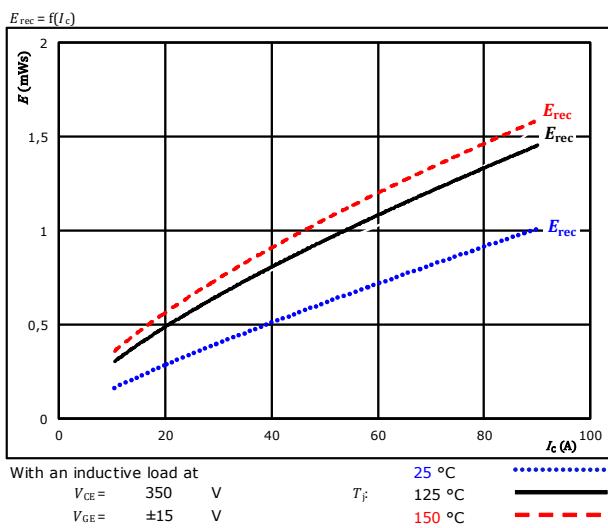
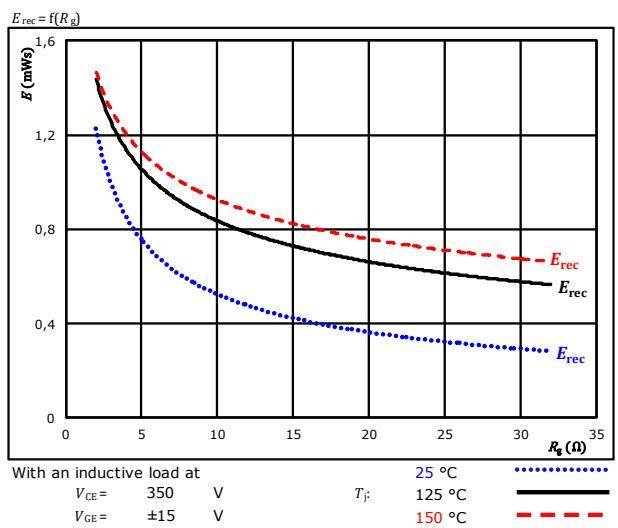


figure 4. FWD

Typical reverse recovered energy loss as a function of gate resistor



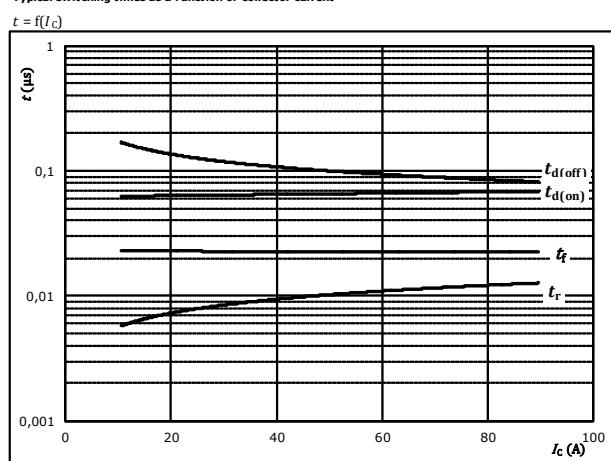


Vincotech

Low Buck / High Buck Switching Characteristics

figure 5.
Typical switching times as a function of collector current

IGBT

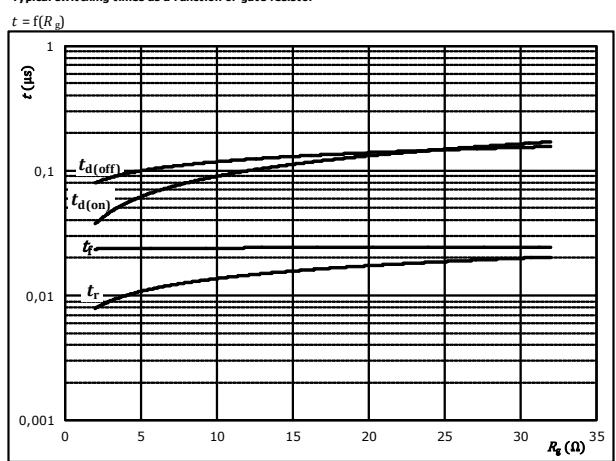


With an inductive load at

$T_J =$	150	°C
$V_{CE} =$	350	V
$V_{GE} =$	±15	V
$R_{gon} =$	8	Ω
$R_{goff} =$	8	Ω

figure 6.
Typical switching times as a function of gate resistor

IGBT



With an inductive load at

$T_J =$	150	°C
$V_{CE} =$	350	V
$V_{GE} =$	±15	V
$I_C =$	50	A

figure 7.
Typical reverse recovery time as a function of collector current

FWD

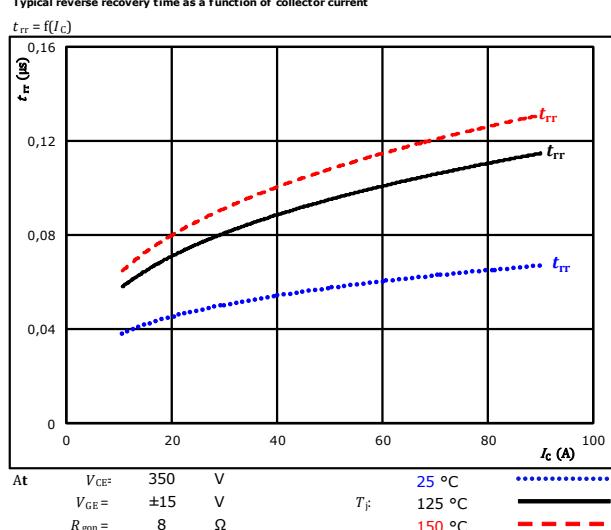
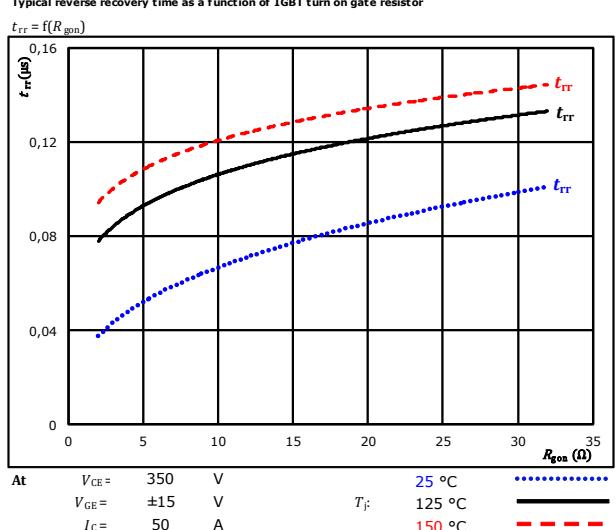


figure 8.
Typical reverse recovery time as a function of IGBT turn on gate resistor

FWD





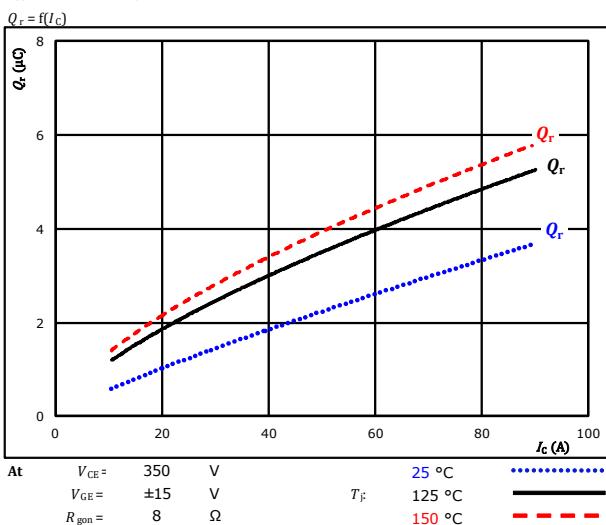
Vincotech

10-FY07BVA050S5-LF44E18
10-PY07BVA050S5-LF44E18Y
datasheet

Low Buck / High Buck Switching Characteristics

figure 9.

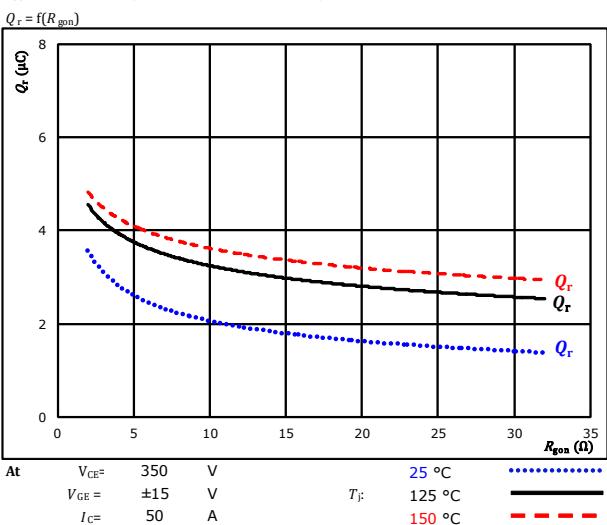
Typical recovered charge as a function of collector current



FWD

figure 10.

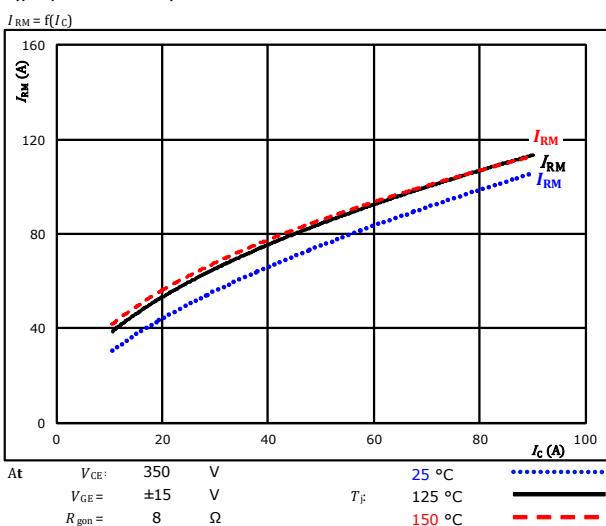
Typical recovered charge as a function of IGBT turn on gate resistor



FWD

figure 11.

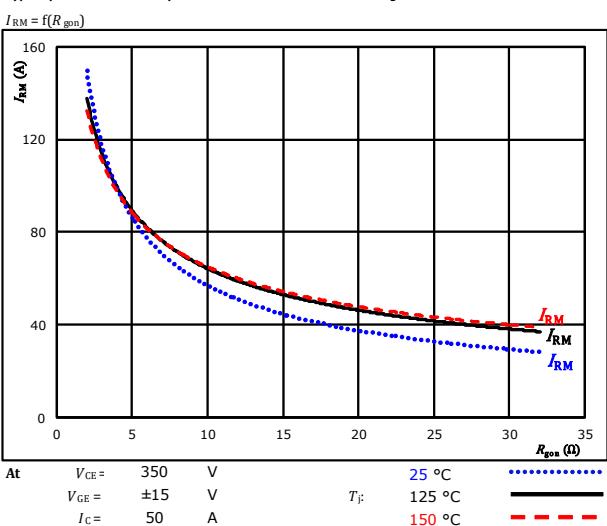
Typical peak reverse recovery current as a function of collector current



FWD

figure 12.

Typical peak reverse recovery current as a function of IGBT turn on gate resistor



FWD



Vincotech

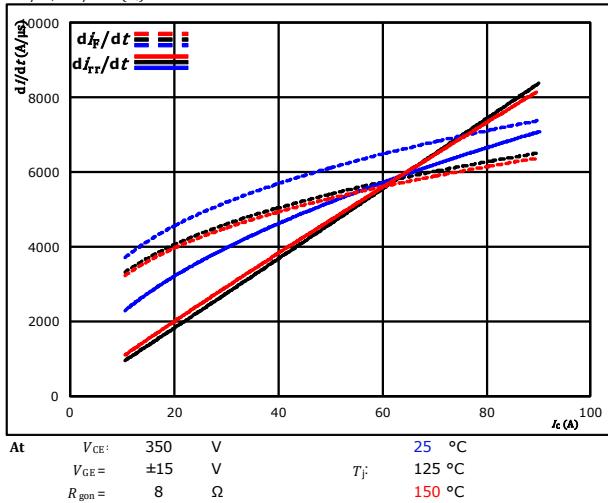
**10-FY07BVA050S5-LF44E18
10-PY07BVA050S5-LF44E18Y**
datasheet

Low Buck / High Buck Switching Characteristics

figure 13.

Typical rate of fall of forward and reverse recovery current as a function of collector current

$di_F/dt, di_{rr}/dt = f(I_C)$

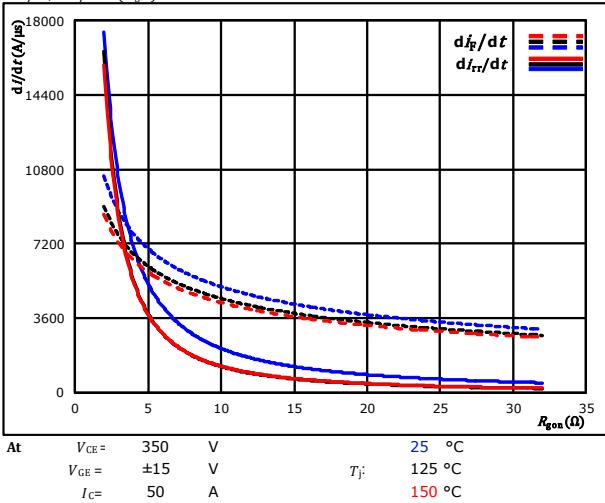


FWD

figure 14.

Typical rate of fall of forward and reverse recovery current as a function of IGBT turn on gate resistor

$di_F/dt, di_{rr}/dt = f(R_{gon})$

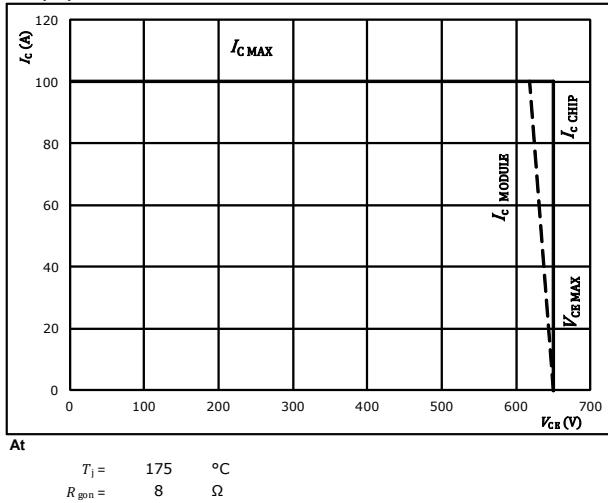


FWD

figure 15.

Reverse bias safe operating area

$I_C = f(V_{CE})$



IGBT



Vincotech

Low Buck / High Buck Switching Definitions

General conditions

T_j	=	125 °C
R_{gon}	=	8 Ω
R_{goff}	=	8 Ω

figure 1.

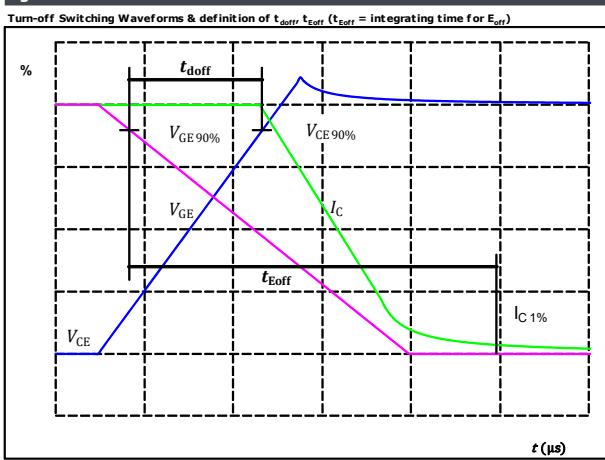


figure 2.

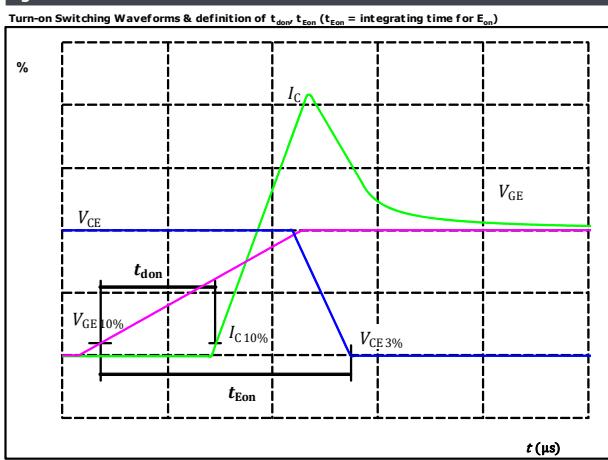


figure 3.

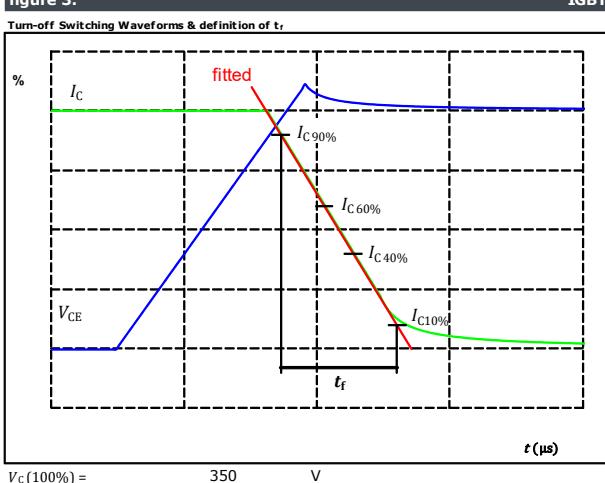
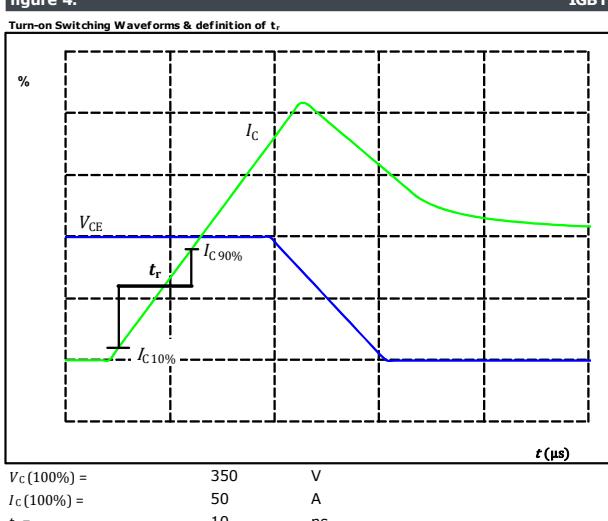


figure 4.

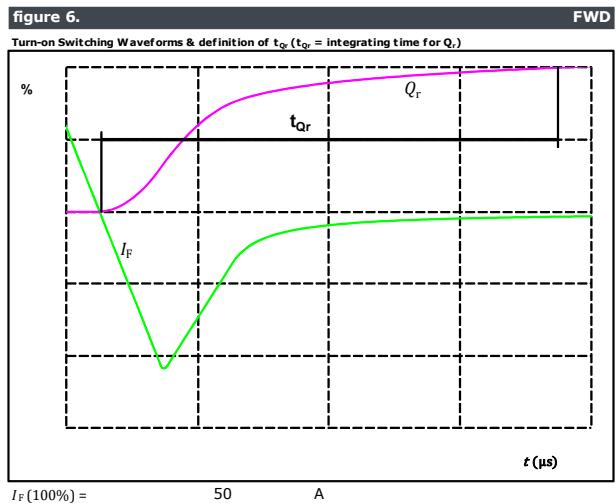
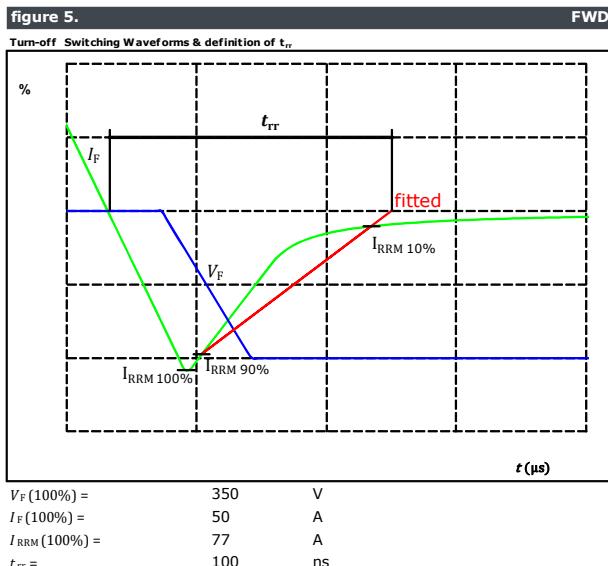




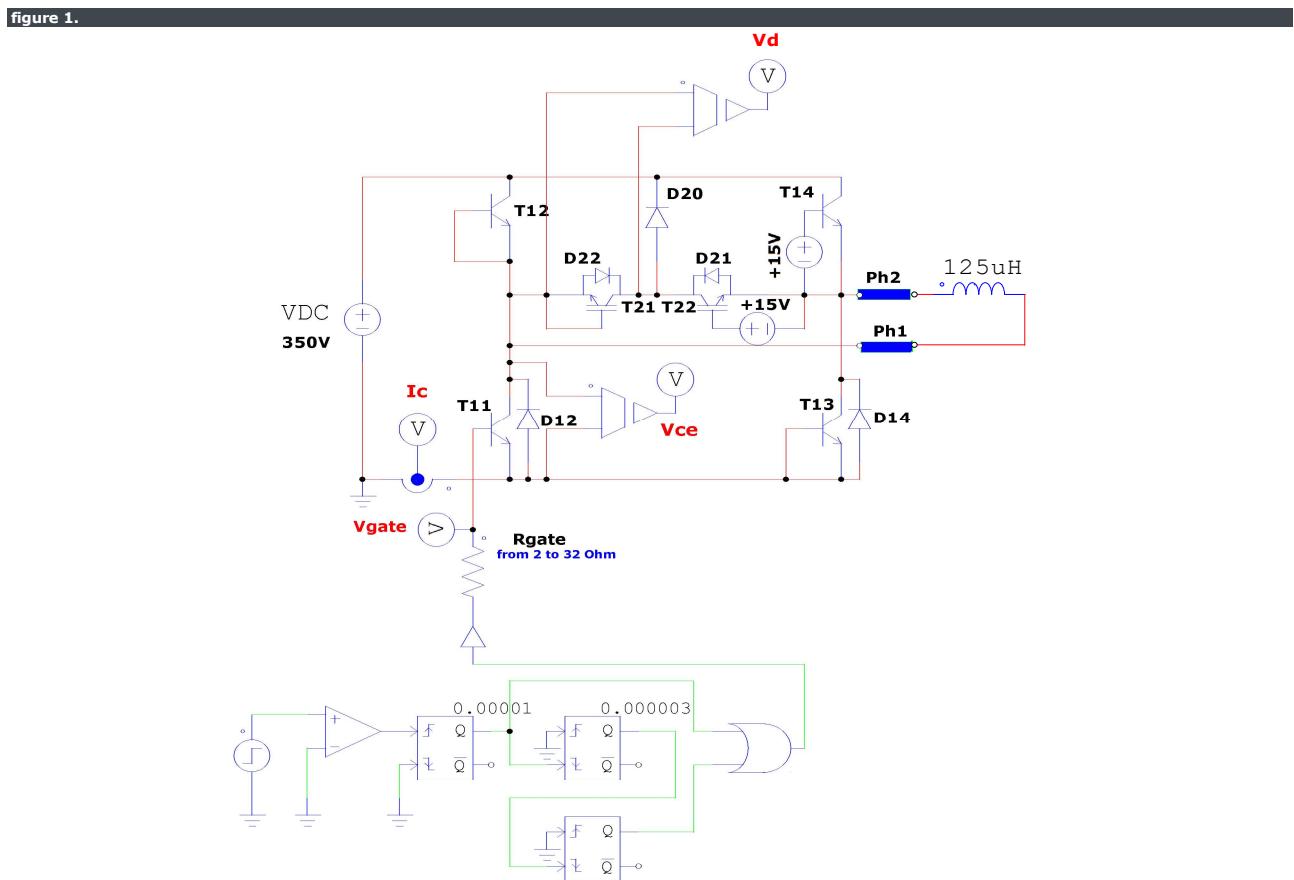
**10-FY07BVA050S5-LF44E18
10-PY07BVA050S5-LF44E18Y**
datasheet

Vincotech

Low Buck / High Buck Switching Characteristics



Low Buck / High Buck Measurement circuits





Vincotech

Low Boost Switching Characteristics

figure 1.

Typical switching energy losses as a function of collector current

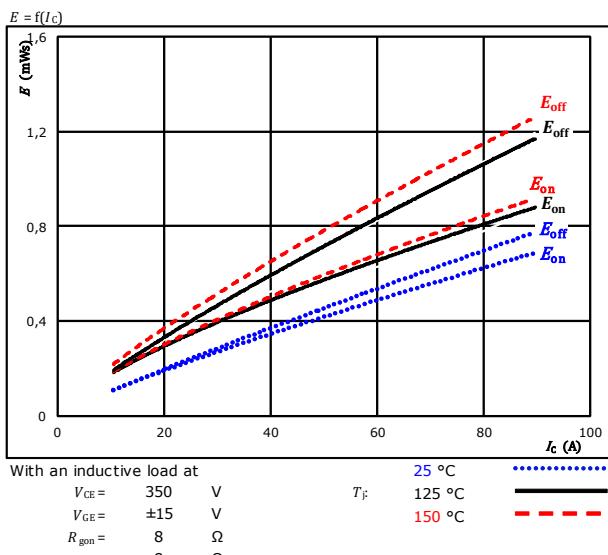


figure 2.

Typical switching energy losses as a function of gate resistor

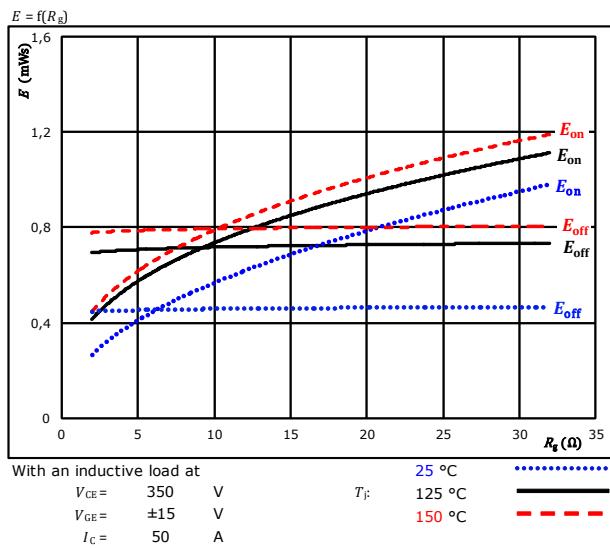


figure 3.

Typical reverse recovered energy loss as a function of collector current

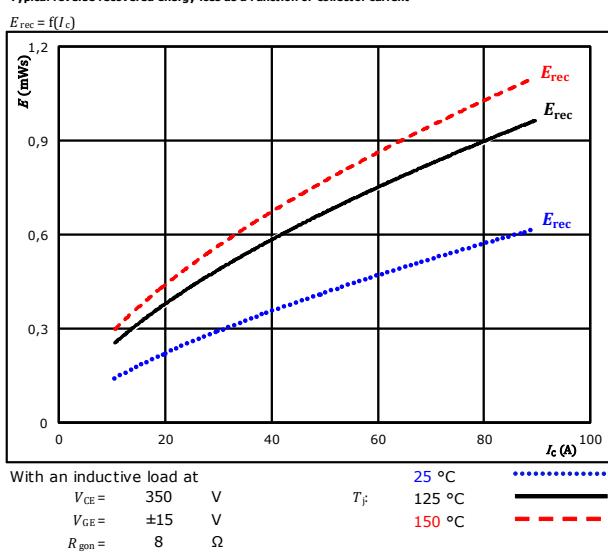
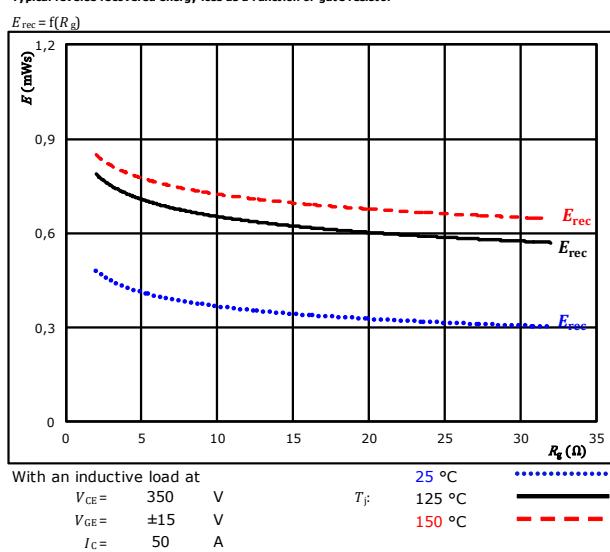


figure 4.

Typical reverse recovered energy loss as a function of gate resistor

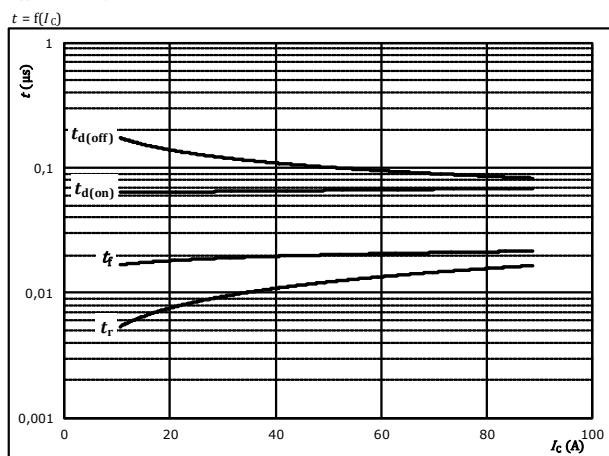




Vincotech

Low Boost Switching Characteristics

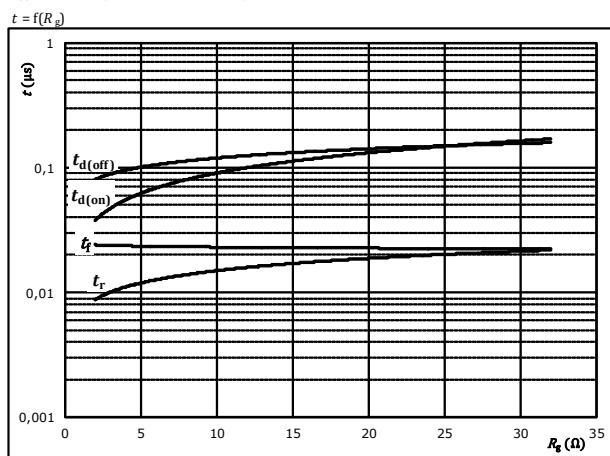
figure 5.
Typical switching times as a function of collector current



With an inductive load at

$T_J =$	150	°C
$V_{CE} =$	350	V
$V_{GE} =$	±15	V
$R_{gon} =$	8	Ω
$R_{goff} =$	8	Ω

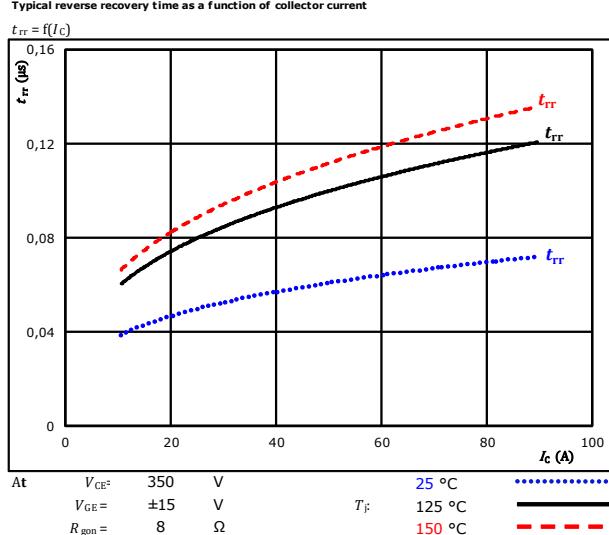
figure 6.
Typical switching times as a function of gate resistor



With an inductive load at

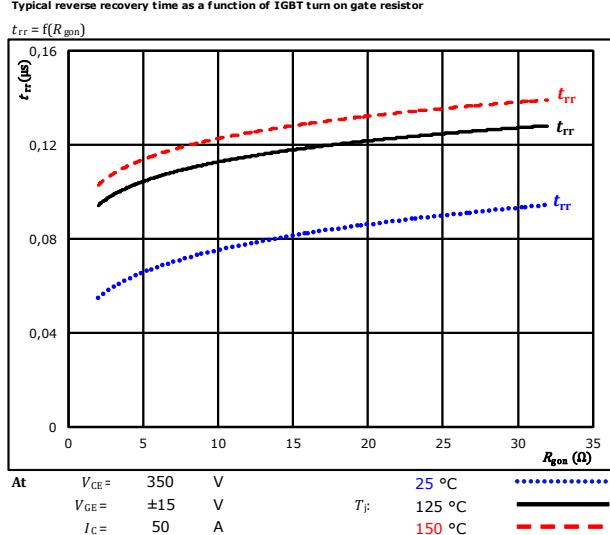
$T_J =$	150	°C
$V_{CE} =$	350	V
$V_{GE} =$	±15	V
$I_C =$	50	A

figure 7.
Typical reverse recovery time as a function of collector current



At	$V_{CE} =$	350	V	$T_J =$	25 °C	$\cdots\cdots\cdots$
	$V_{GE} =$	±15	V		125 °C	—
	$R_{gon} =$	8	Ω		150 °C	- - -

figure 8.
Typical reverse recovery time as a function of IGBT turn on gate resistor



At	$V_{CE} =$	350	V	$T_J =$	25 °C	$\cdots\cdots\cdots$
	$V_{GE} =$	±15	V		125 °C	—
	$I_C =$	50	A		150 °C	- - -



Vincotech

**10-FY07BVA050S5-LF44E18
10-PY07BVA050S5-LF44E18Y**
datasheet

Low Boost Switching Characteristics

figure 9.

Typical recovered charge as a function of collector current

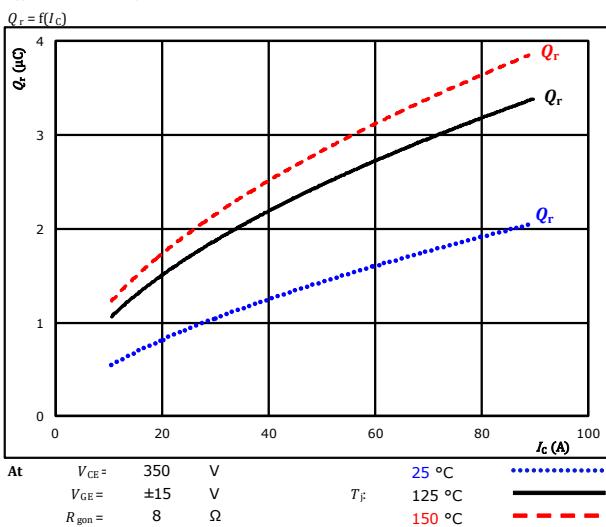


figure 10.

Typical recovered charge as a function of IGBT turn on gate resistor

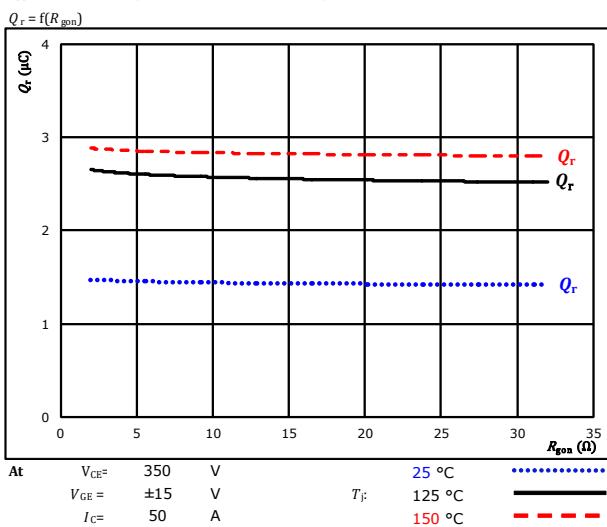


figure 11.

Typical peak reverse recovery current as a function of collector current

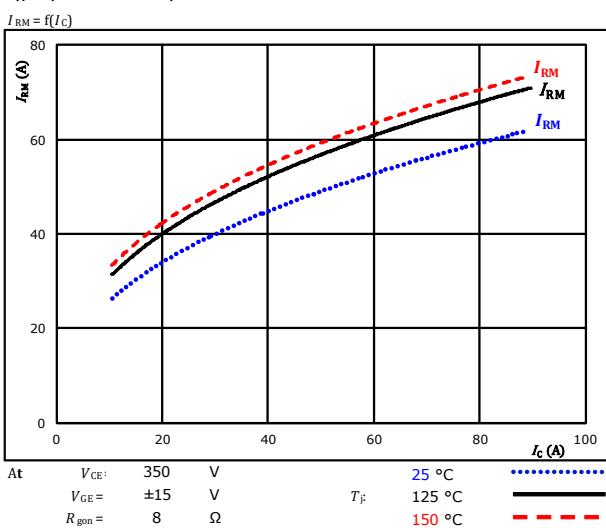
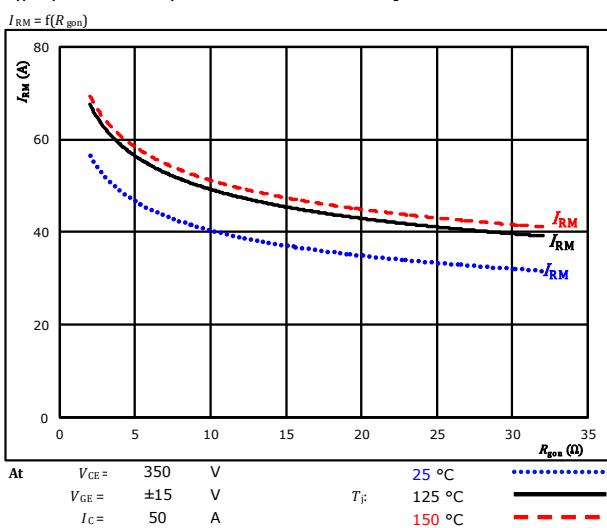


figure 12.

Typical peak reverse recovery current as a function of IGBT turn on gate resistor





Vincotech

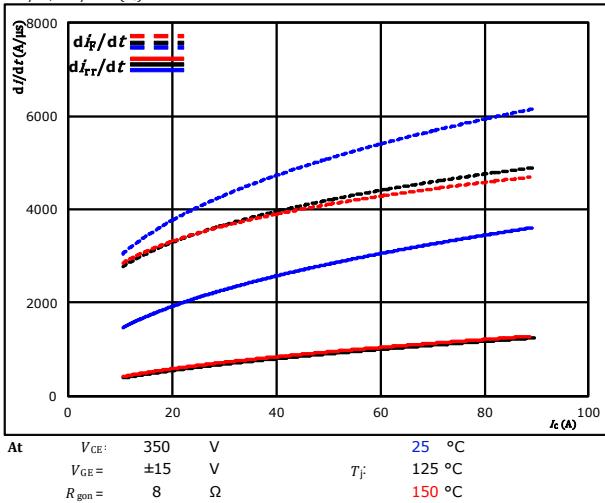
**10-FY07BVA050S5-LF44E18
10-PY07BVA050S5-LF44E18Y**
datasheet

Low Boost Switching Characteristics

figure 13.

Typical rate of fall of forward and reverse recovery current as a function of collector current

$di_F/dt, di_{rr}/dt = f(I_C)$

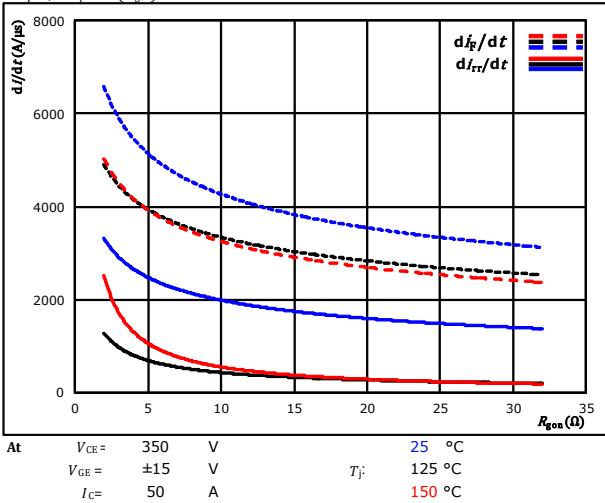


FWD

figure 14.

Typical rate of fall of forward and reverse recovery current as a function of IGBT turn on gate resistor

$di_F/dt, di_{rr}/dt = f(R_{gon})$

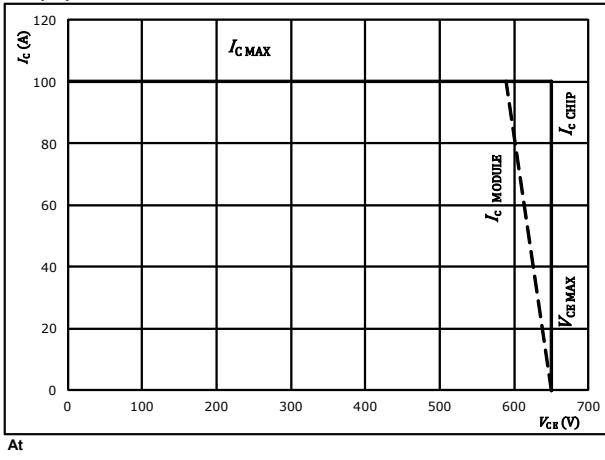


FWD

figure 15.

Reverse bias safe operating area

$I_C = f(V_{CE})$



IGBT



10-FY07BVA050S5-LF44E18
10-PY07BVA050S5-LF44E18Y
datasheet

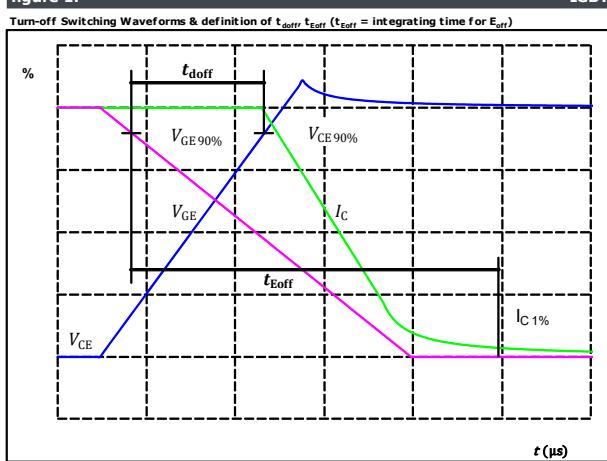
Vincotech

Low Boost Switching Definitions

General conditions

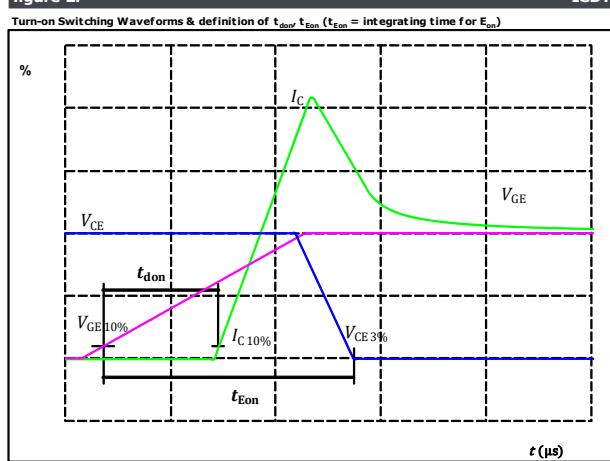
T_j	=	125 °C
R_{gon}	=	8 Ω
R_{goff}	=	8 Ω

figure 1.



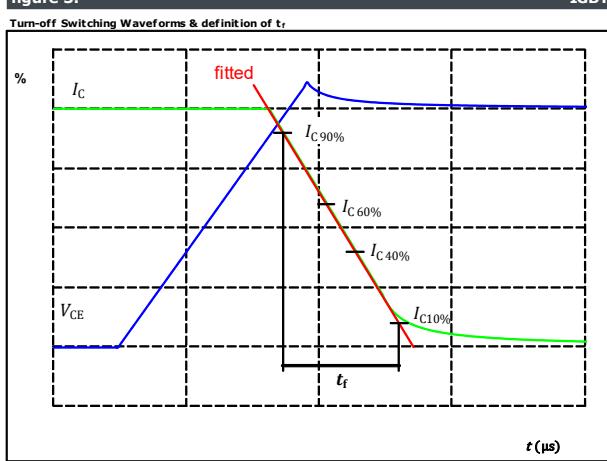
$V_{GE(0\%)} = -15 \text{ V}$
 $V_{GE(100\%)} = 15 \text{ V}$
 $V_C(100\%) = 350 \text{ V}$
 $I_C(100\%) = 50 \text{ A}$
 $t_{doff} = 96 \text{ ns}$

figure 2.



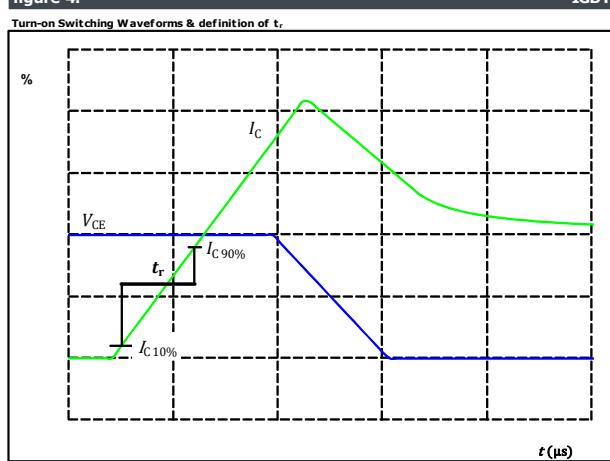
$V_{GE(0\%)} = -15 \text{ V}$
 $V_{GE(100\%)} = 15 \text{ V}$
 $V_C(100\%) = 350 \text{ V}$
 $I_C(100\%) = 50 \text{ A}$
 $t_{don} = 65 \text{ ns}$

figure 3.



$V_C(100\%) = 350 \text{ V}$
 $I_C(100\%) = 50 \text{ A}$
 $t_f = 20 \text{ ns}$

figure 4.



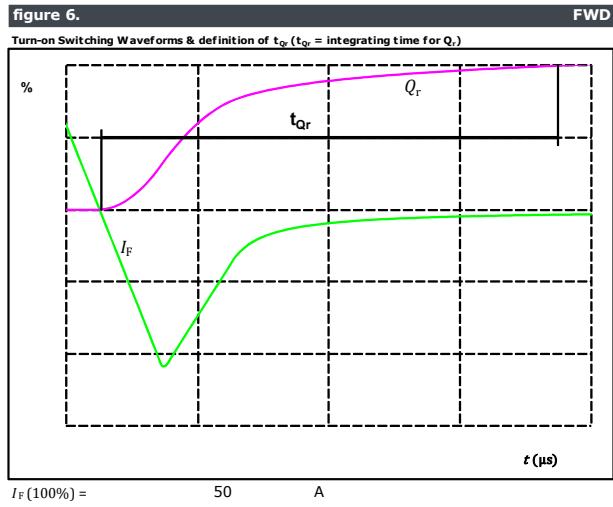
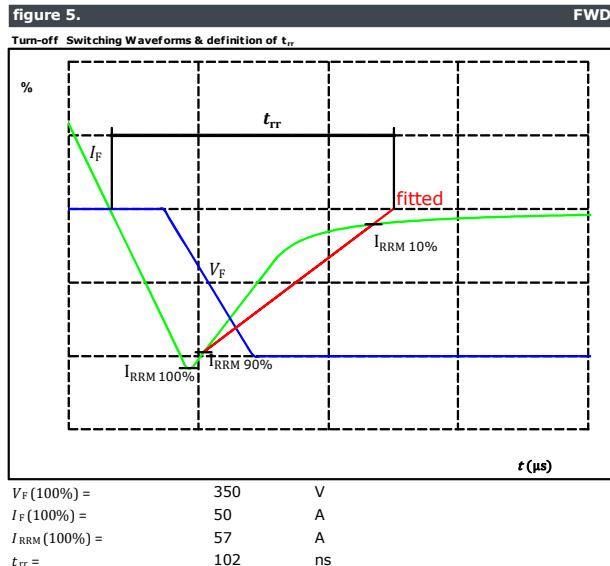
$V_C(100\%) = 350 \text{ V}$
 $I_C(100\%) = 50 \text{ A}$
 $t_r = 12 \text{ ns}$



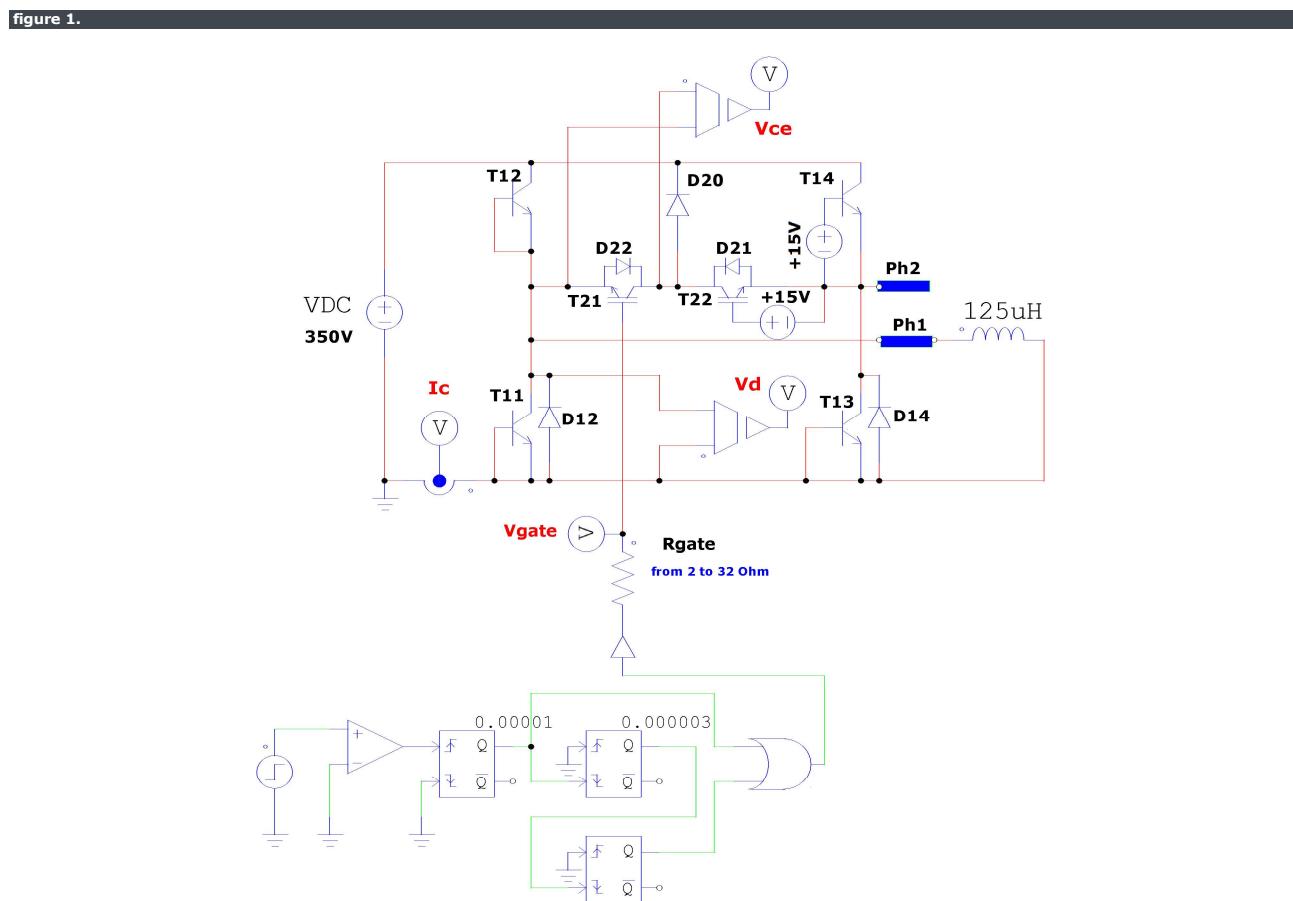
**10-FY07BVA050S5-LF44E18
10-PY07BVA050S5-LF44E18Y**
datasheet

Vincotech

Low Boost Switching Characteristics



Low Boost Measurement circuits





Vincotech

High Boost Switching Characteristics

figure 1. IGBT

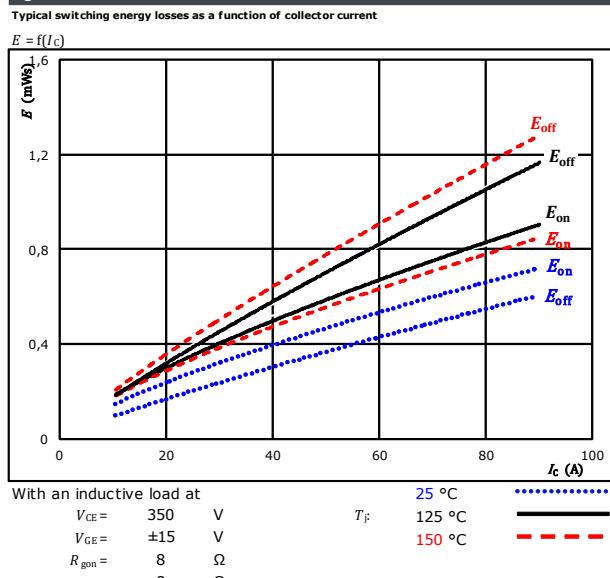


figure 2. IGBT

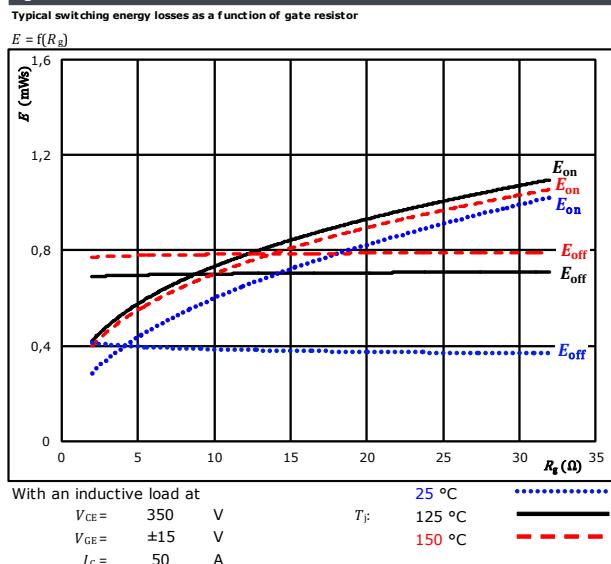


figure 3. FWD

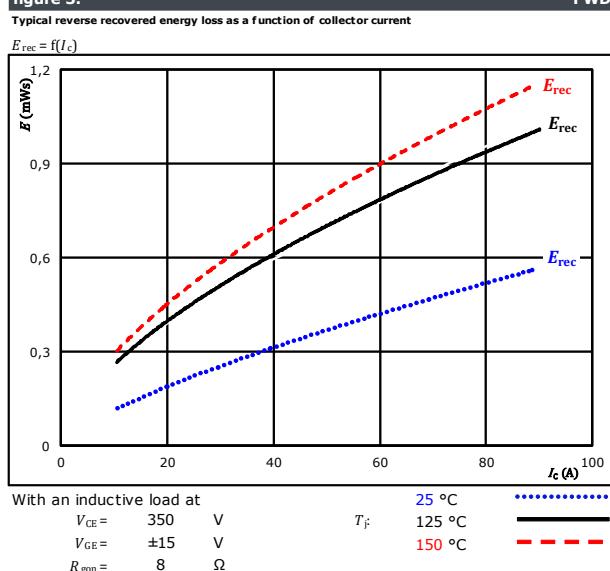
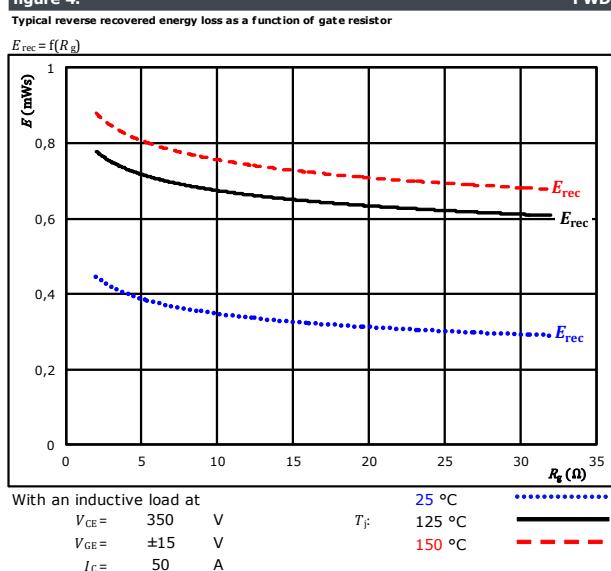


figure 4. FWD





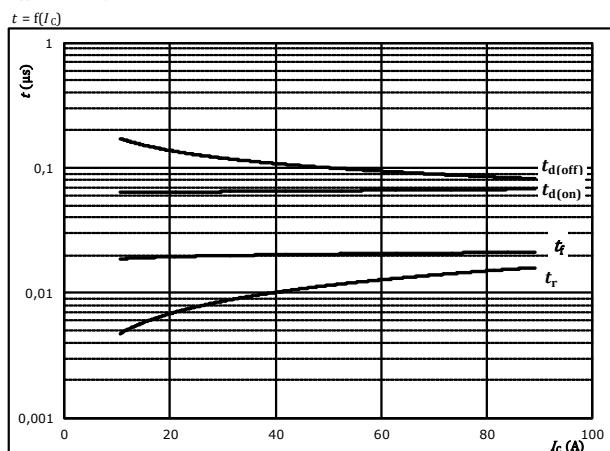
**10-FY07BVA050S5-LF44E18
10-PY07BVA050S5-LF44E18Y**
datasheet

Vincotech

High Boost Switching Characteristics

figure 5. IGBT

Typical switching times as a function of collector current



With an inductive load at

$T_J = 150^\circ\text{C}$

$V_{CE} = 350 \text{ V}$

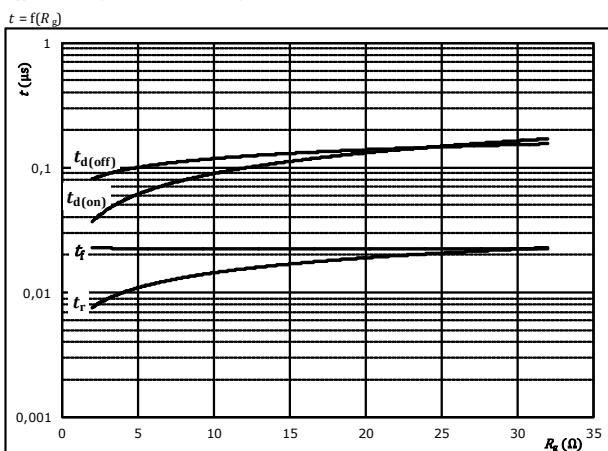
$V_{GE} = \pm 15 \text{ V}$

$R_{gon} = 8 \Omega$

$R_{goff} = 8 \Omega$

figure 6. IGBT

Typical switching times as a function of gate resistor



With an inductive load at

$T_J = 150^\circ\text{C}$

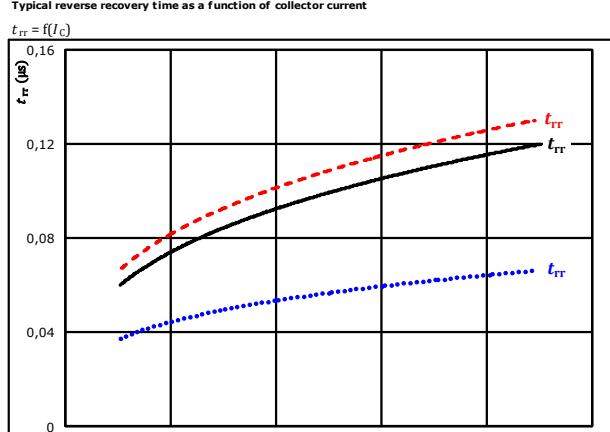
$V_{CE} = 350 \text{ V}$

$V_{GE} = \pm 15 \text{ V}$

$I_C = 50 \text{ A}$

figure 7. FWD

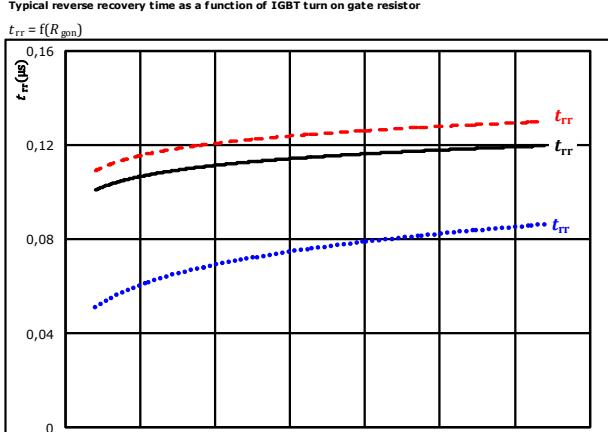
Typical reverse recovery time as a function of collector current



At $V_{CE} = 350 \text{ V}$ $T_J = 25^\circ\text{C}$ $t_{rr} = \dots$
 $V_{GE} = \pm 15 \text{ V}$ $T_f = 125^\circ\text{C}$ $t_{rr} = \dots$
 $R_{gon} = 8 \Omega$ 150°C $t_{rr} = \dots$

figure 8. FWD

Typical reverse recovery time as a function of IGBT turn on gate resistor



At $V_{CE} = 350 \text{ V}$ $T_J = 25^\circ\text{C}$ $t_{rr} = \dots$
 $V_{GE} = \pm 15 \text{ V}$ $T_f = 125^\circ\text{C}$ $t_{rr} = \dots$
 $I_C = 50 \text{ A}$ 150°C $t_{rr} = \dots$

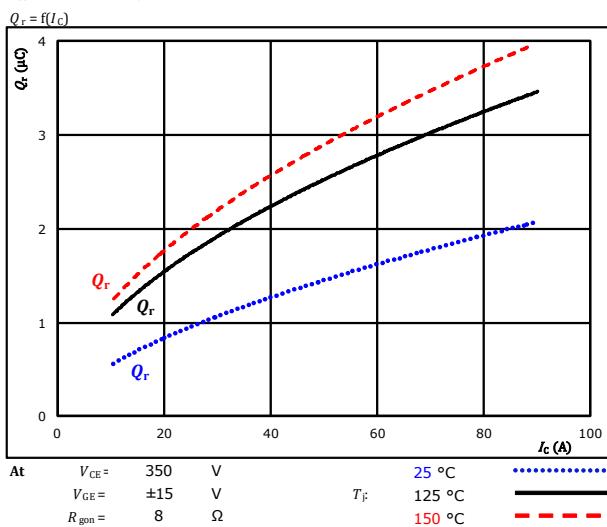


Vincotech

High Boost Switching Characteristics

figure 9.

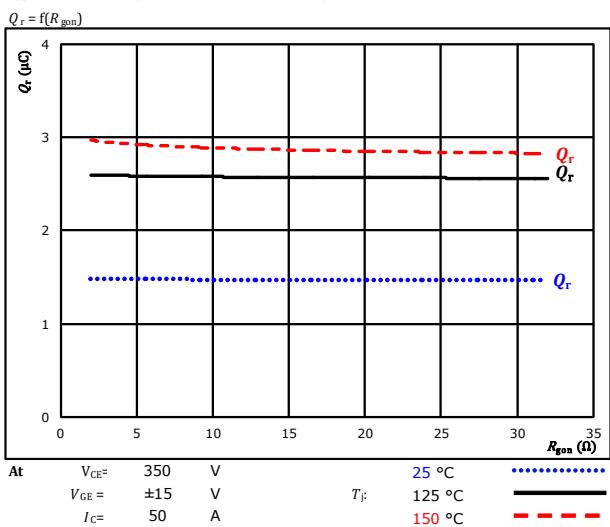
Typical recovered charge as a function of collector current



FWD

figure 10.

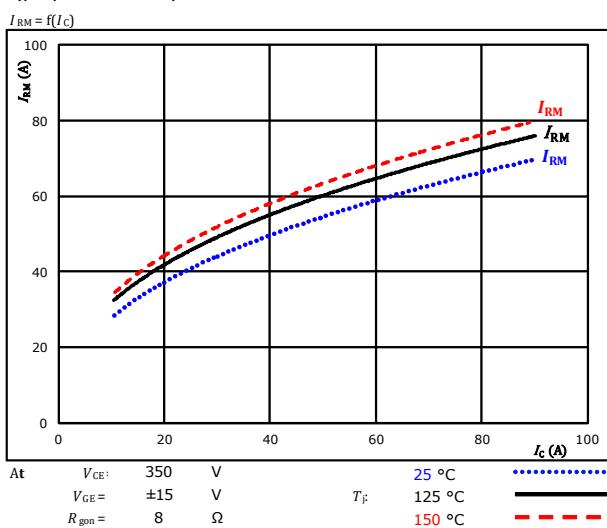
Typical recovered charge as a function of IGBT turn on gate resistor



FWD

figure 11.

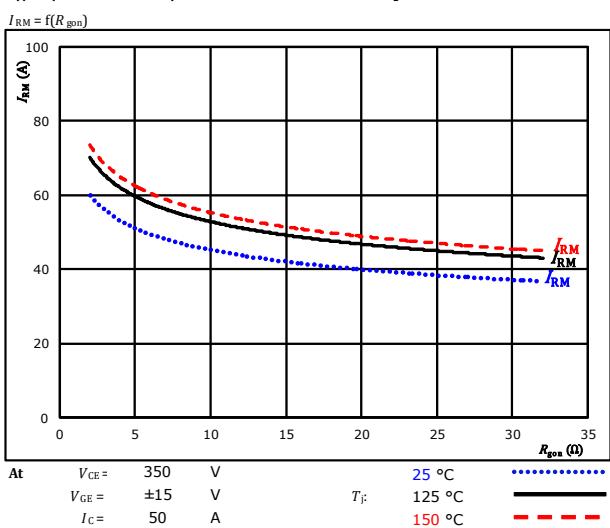
Typical peak reverse recovery current as a function of collector current



FWD

figure 12.

Typical peak reverse recovery current as a function of IGBT turn on gate resistor



FWD



Vincotech

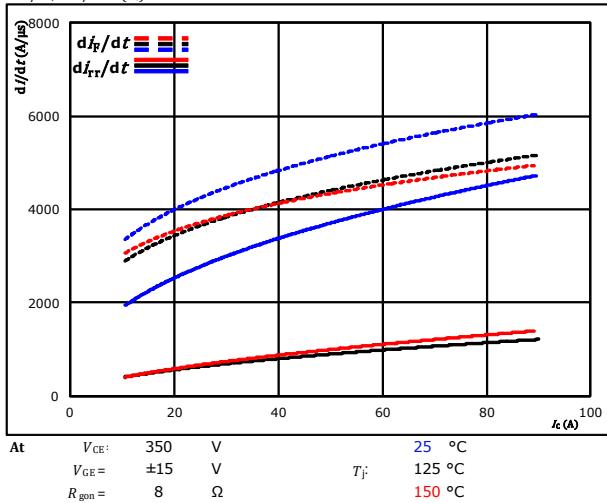
**10-FY07BVA050S5-LF44E18
10-PY07BVA050S5-LF44E18Y**
datasheet

High Boost Switching Characteristics

figure 13.

Typical rate of fall of forward and reverse recovery current as a function of collector current

$di_F/dt, di_{rr}/dt = f(I_C)$

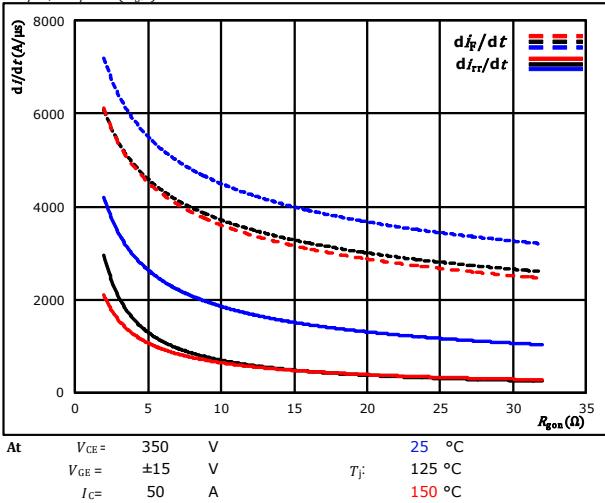


FWD

figure 14.

Typical rate of fall of forward and reverse recovery current as a function of IGBT turn on gate resistor

$di_F/dt, di_{rr}/dt = f(R_{gon})$

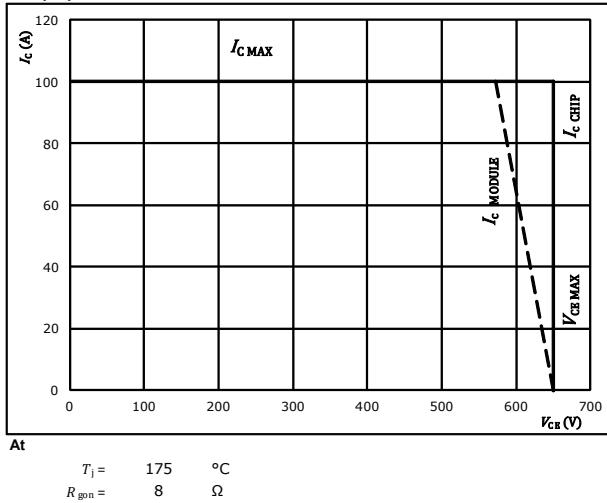


FWD

figure 15.

Reverse bias safe operating area

$I_C = f(V_{CE})$



IGBT



Vincotech

**10-FY07BVA050S5-LF44E18
10-PY07BVA050S5-LF44E18Y**
datasheet

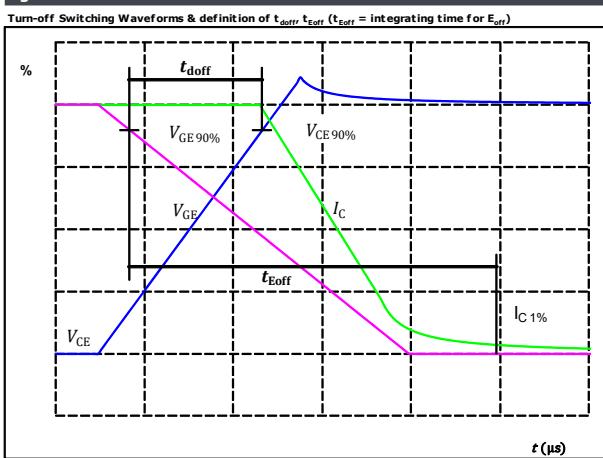
High Boost Switching Definitions

General conditions

T_j	=	125 °C
R_{gon}	=	8 Ω
R_{goff}	=	8 Ω

figure 1.

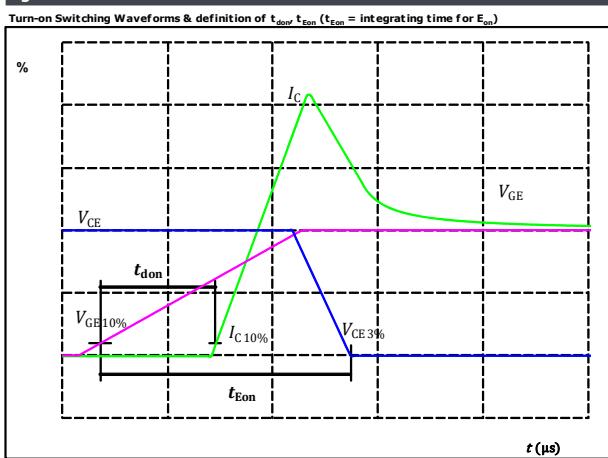
IGBT



$V_{GE}(0\%) = -15 \text{ V}$
 $V_{GE}(100\%) = 15 \text{ V}$
 $V_C(100\%) = 350 \text{ V}$
 $I_C(100\%) = 50 \text{ A}$
 $t_{doff} = 96 \text{ ns}$

figure 2.

IGBT

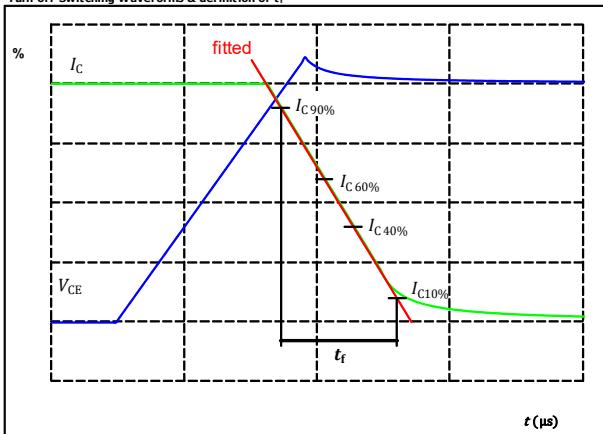


$V_{GE}(0\%) = -15 \text{ V}$
 $V_{GE}(100\%) = 15 \text{ V}$
 $V_C(100\%) = 350 \text{ V}$
 $I_C(100\%) = 50 \text{ A}$
 $t_{don} = 66 \text{ ns}$

figure 3.

IGBT

Turn-off Switching Waveforms & definition of t_f

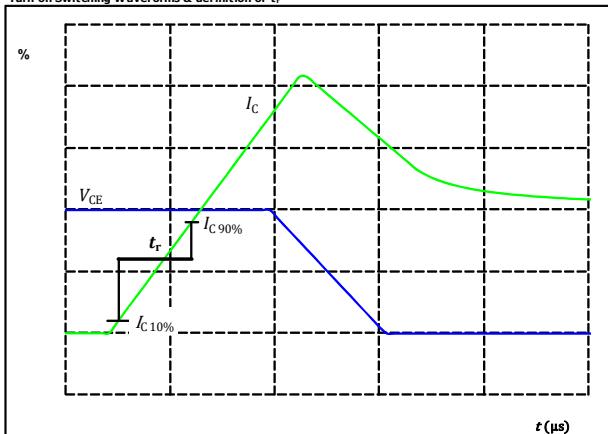


$V_C(100\%) = 350 \text{ V}$
 $I_C(100\%) = 50 \text{ A}$
 $t_f = 19 \text{ ns}$

figure 4.

IGBT

Turn-on Switching Waveforms & definition of t_r



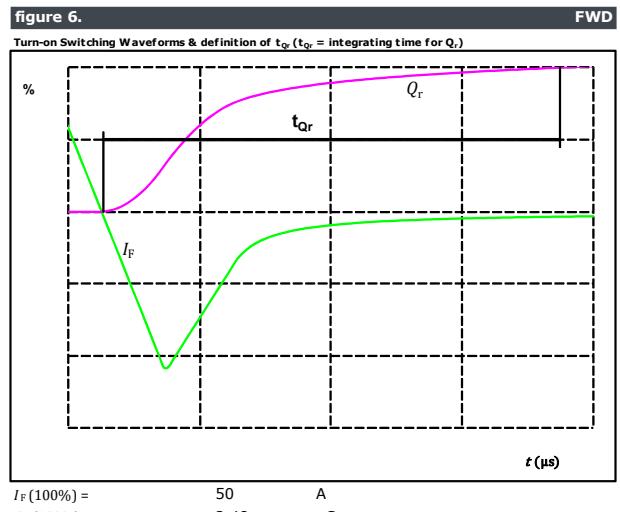
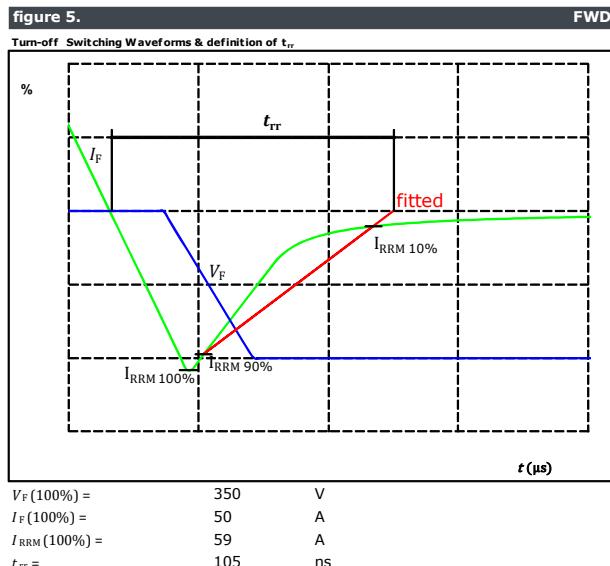
$V_C(100\%) = 350 \text{ V}$
 $I_C(100\%) = 50 \text{ A}$
 $t_r = 11 \text{ ns}$



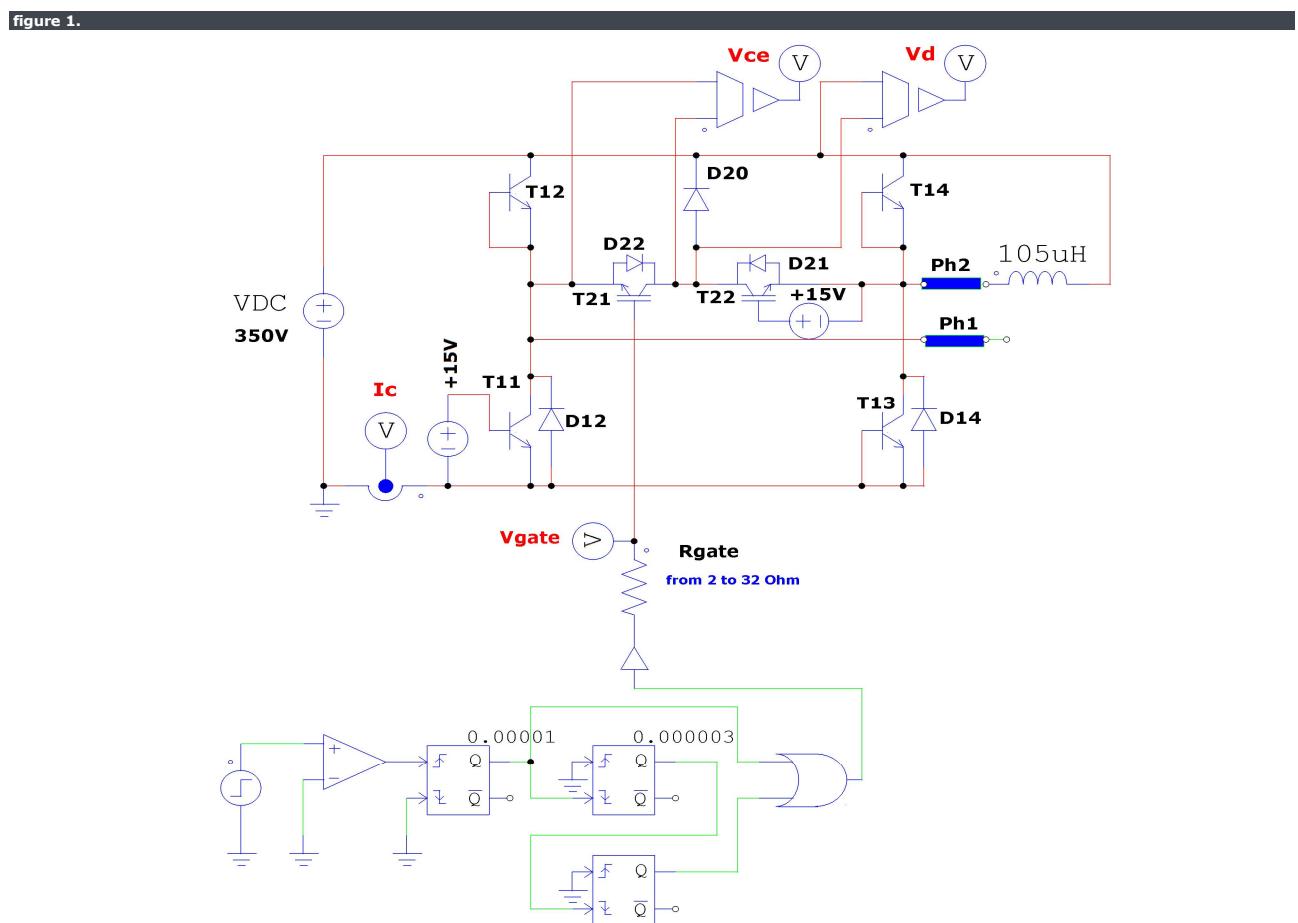
**10-FY07BVA050S5-LF44E18
10-PY07BVA050S5-LF44E18Y**
datasheet

Vincotech

High Boost Switching Characteristics



High Boost Measurement circuits





Input Boost Switching Characteristics

figure 1.

Typical switching energy losses as a function of collector current

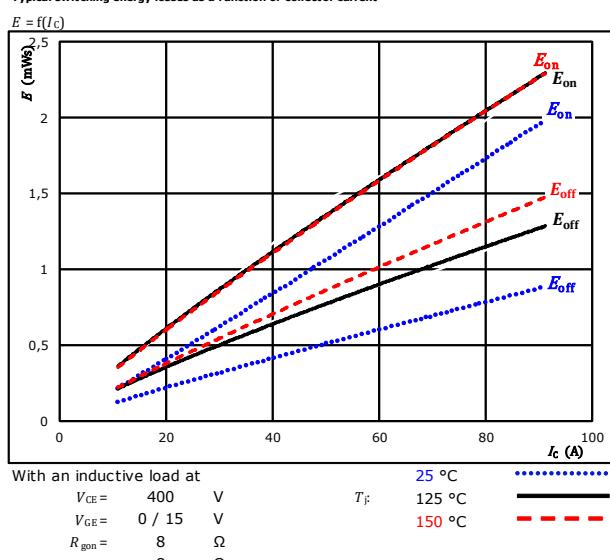


figure 2.

Typical switching energy losses as a function of gate resistor

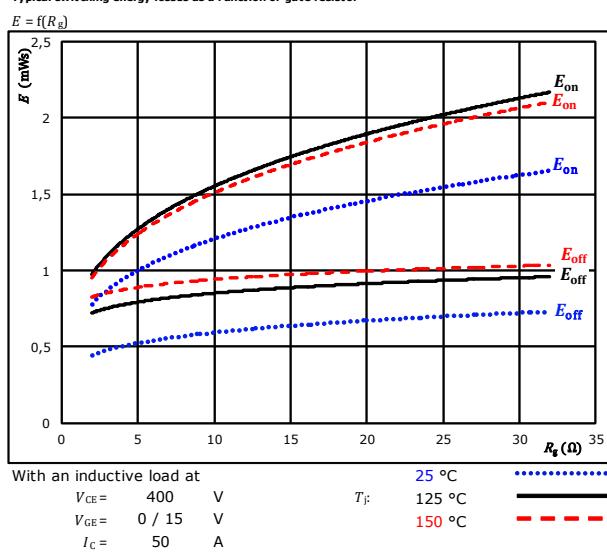


figure 3.

Typical reverse recovered energy loss as a function of collector current

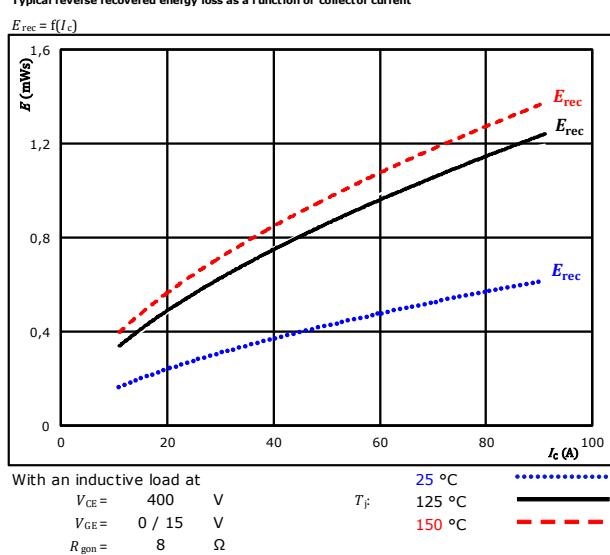
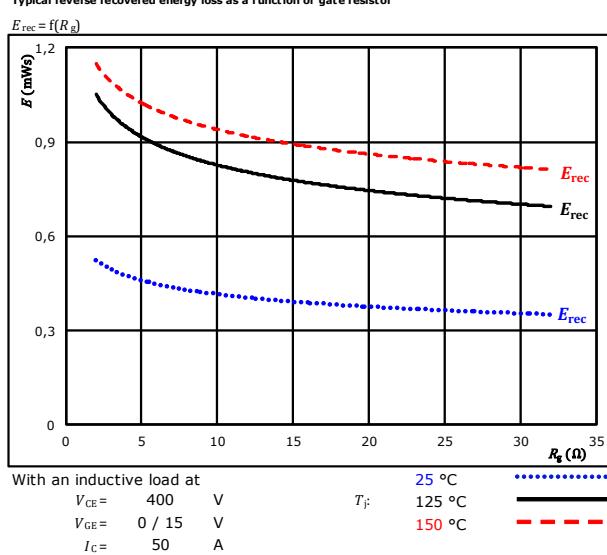


figure 4.

Typical reverse recovered energy loss as a function of gate resistor

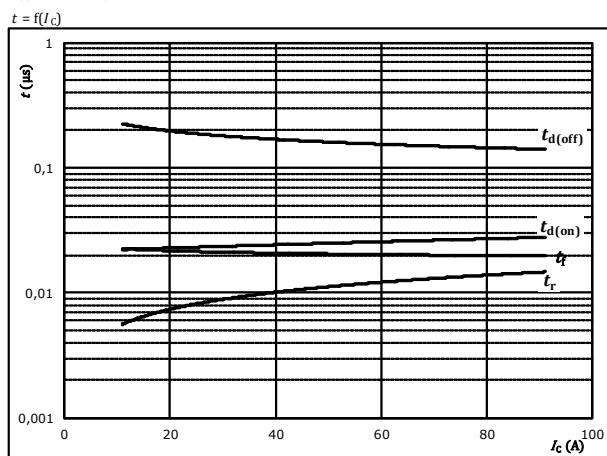




Vincotech

Input Boost Switching Characteristics

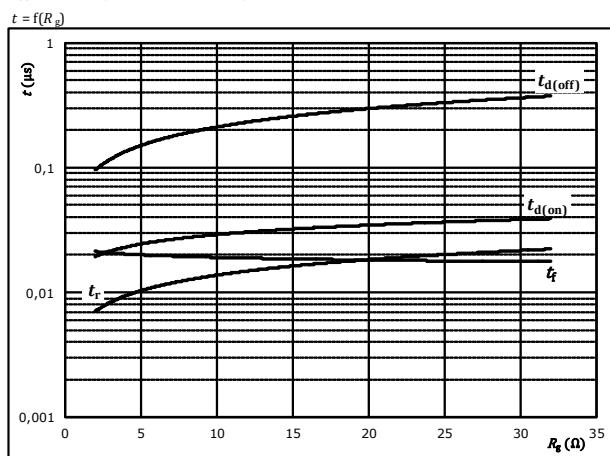
figure 5.
Typical switching times as a function of collector current



With an inductive load at

$T_J = 150^\circ\text{C}$
 $V_{CE} = 400 \text{ V}$
 $V_{GE} = 0 / 15 \text{ V}$
 $R_{gon} = 8 \Omega$
 $R_{goff} = 8 \Omega$

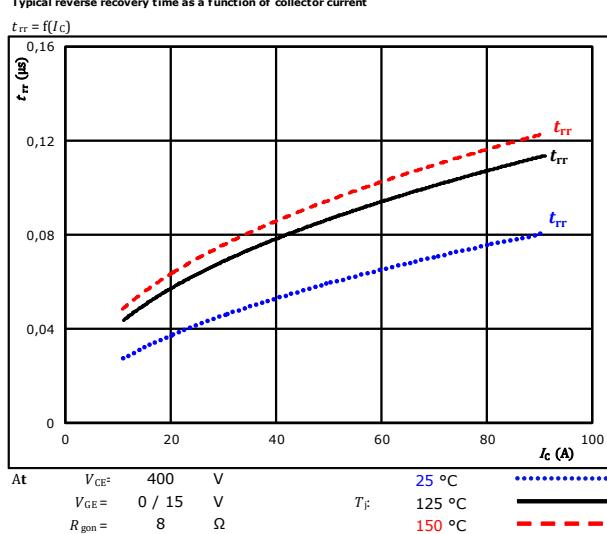
figure 6.
Typical switching times as a function of gate resistor



With an inductive load at

$T_J = 150^\circ\text{C}$
 $V_{CE} = 400 \text{ V}$
 $V_{GE} = 0 / 15 \text{ V}$
 $I_C = 50 \text{ A}$

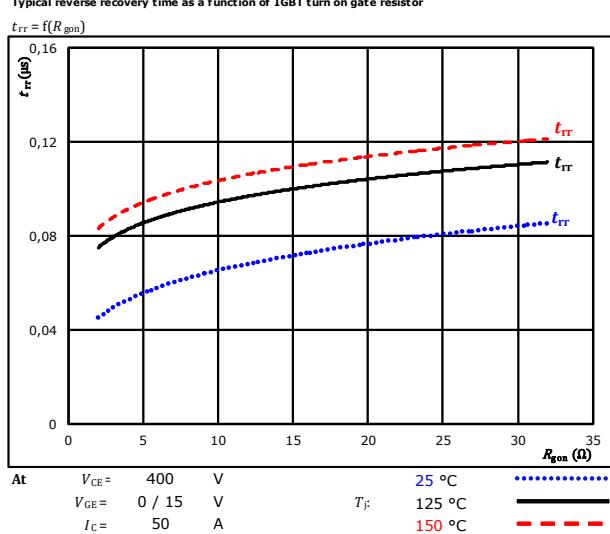
figure 7.
Typical reverse recovery time as a function of collector current



At $V_{CE} = 400 \text{ V}$
 $V_{GE} = 0 / 15 \text{ V}$
 $R_{gon} = 8 \Omega$

$T_J = 25^\circ\text{C}$
 $T_f = 125^\circ\text{C}$
 150°C

figure 8.
Typical reverse recovery time as a function of IGBT turn on gate resistor



At $V_{CE} = 400 \text{ V}$
 $V_{GE} = 0 / 15 \text{ V}$
 $I_C = 50 \text{ A}$

$T_J = 25^\circ\text{C}$
 $T_f = 125^\circ\text{C}$
 150°C

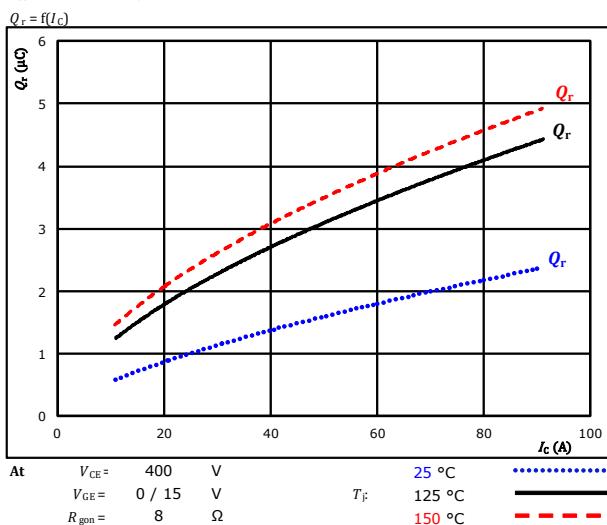


Vincotech

Input Boost Switching Characteristics

figure 9.

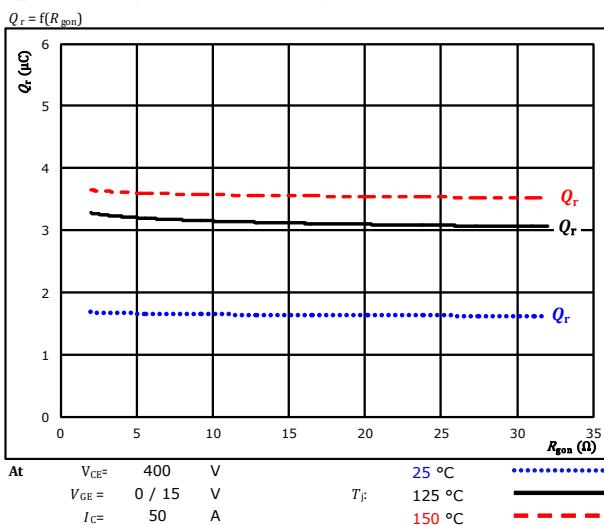
Typical recovered charge as a function of collector current



FWD

figure 10.

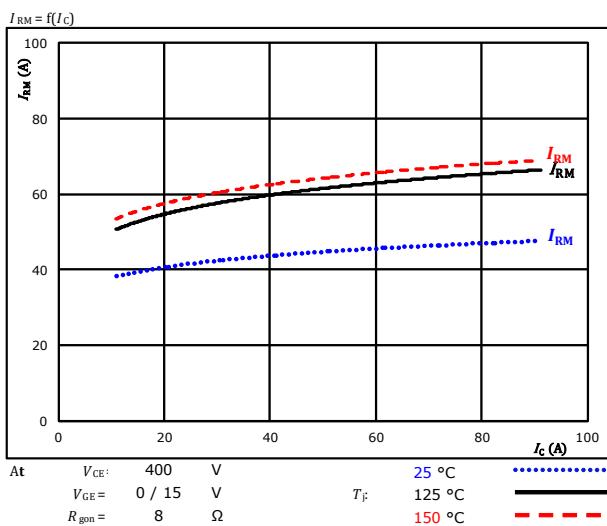
Typical recovered charge as a function of IGBT turn on gate resistor



FWD

figure 11.

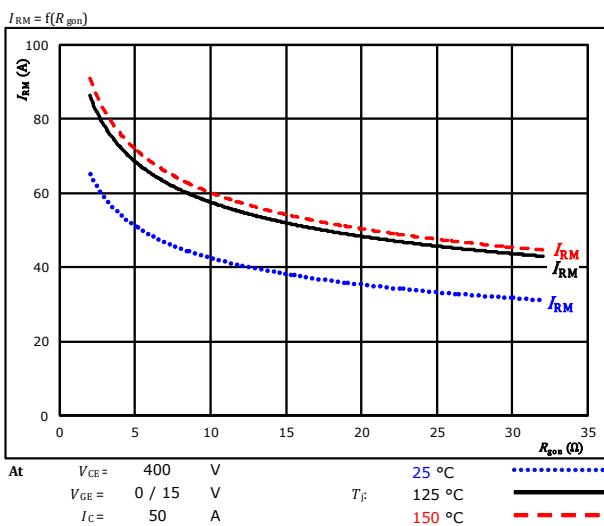
Typical peak reverse recovery current as a function of collector current



FWD

figure 12.

Typical peak reverse recovery current as a function of IGBT turn on gate resistor



FWD



Vincotech

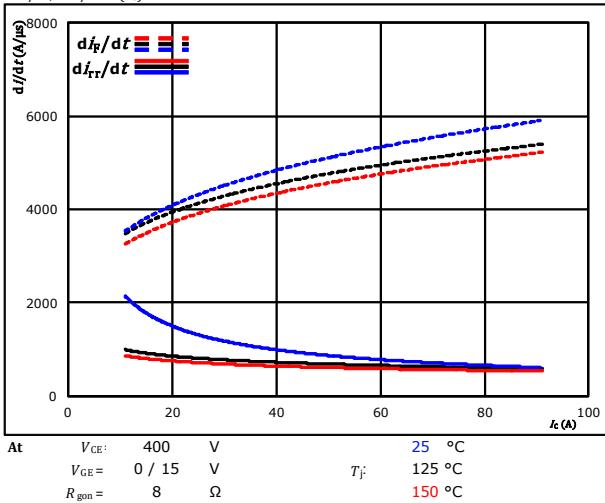
**10-FY07BVA050S5-LF44E18
10-PY07BVA050S5-LF44E18Y**
datasheet

Input Boost Switching Characteristics

figure 13.

Typical rate of fall of forward and reverse recovery current as a function of collector current

$di_F/dt, di_{rr}/dt = f(I_C)$

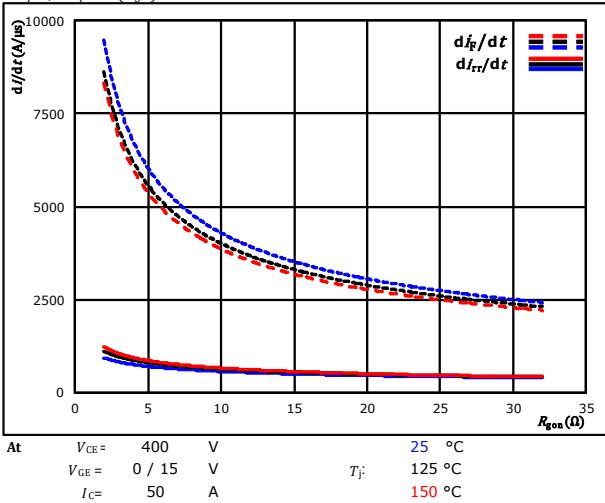


FWD

figure 14.

Typical rate of fall of forward and reverse recovery current as a function of IGBT turn on gate resistor

$di_F/dt, di_{rr}/dt = f(R_{gon})$

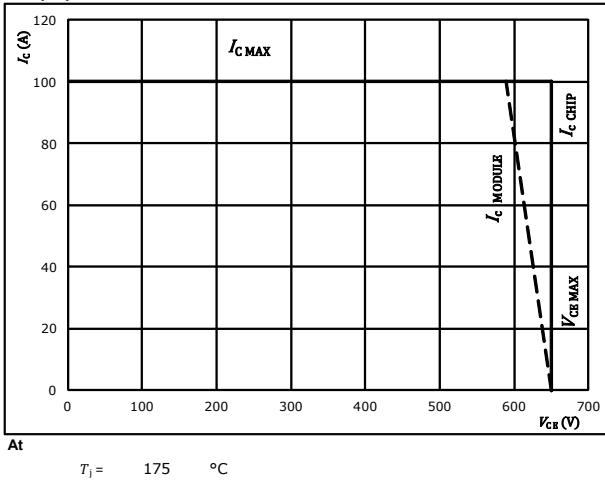


FWD

figure 15.

Reverse bias safe operating area

$I_C = f(V_{CE})$



IGBT



Vincotech

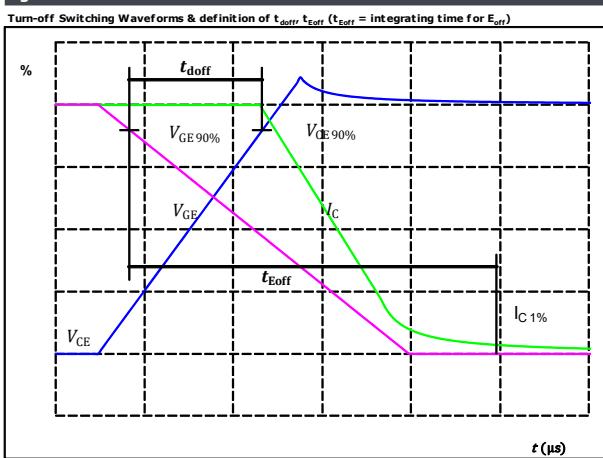
Input Boost Switching Definitions

General conditions

T_j	=	125 °C
R_{gon}	=	8 Ω
R_{goff}	=	8 Ω

figure 1.

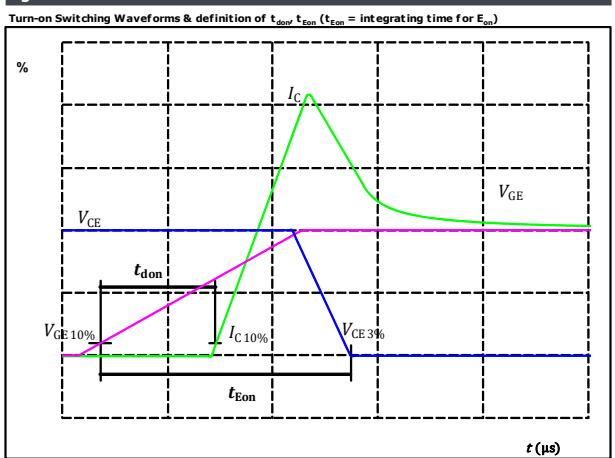
IGBT



$V_{GE}(0\%) =$	0	V
$V_{GE}(100\%) =$	15	V
$V_C(100\%) =$	400	V
$I_C(100\%) =$	50	A
$t_{doff} =$	156	ns

figure 2.

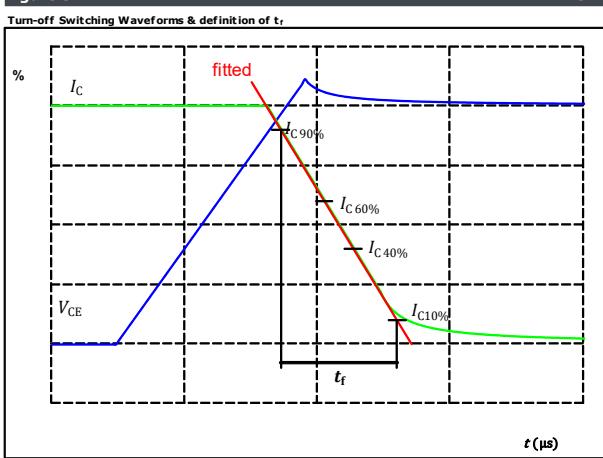
IGBT



$V_{GE}(0\%) =$	0	V
$V_{GE}(100\%) =$	15	V
$V_C(100\%) =$	400	V
$I_C(100\%) =$	50	A
$t_{don} =$	25	ns

figure 3.

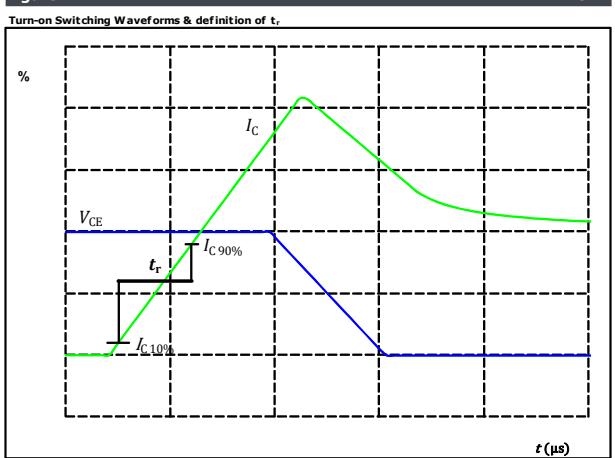
IGBT



$V_C(100\%) =$	400	V
$I_C(100\%) =$	50	A
$t_f =$	17	ns

figure 4.

IGBT



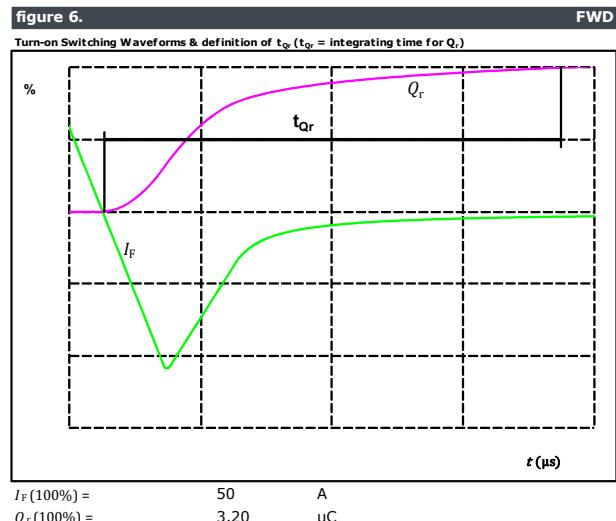
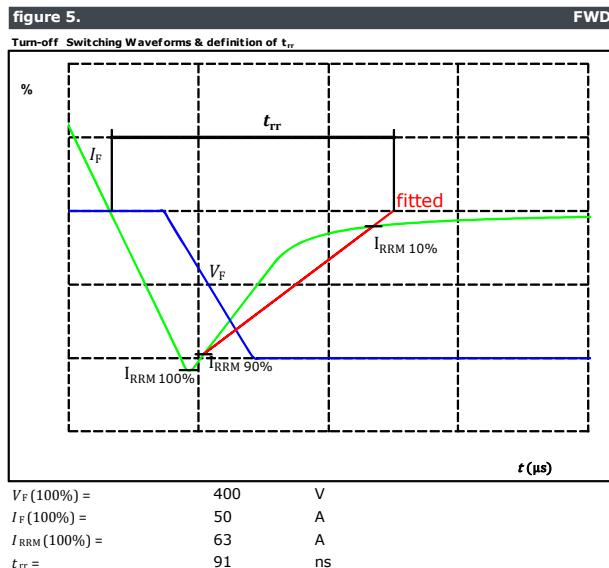
$V_C(100\%) =$	400	V
$I_C(100\%) =$	50	A
$t_r =$	10	ns



10-FY07BVA050S5-LF44E18
10-PY07BVA050S5-LF44E18Y
datasheet

Vincotech

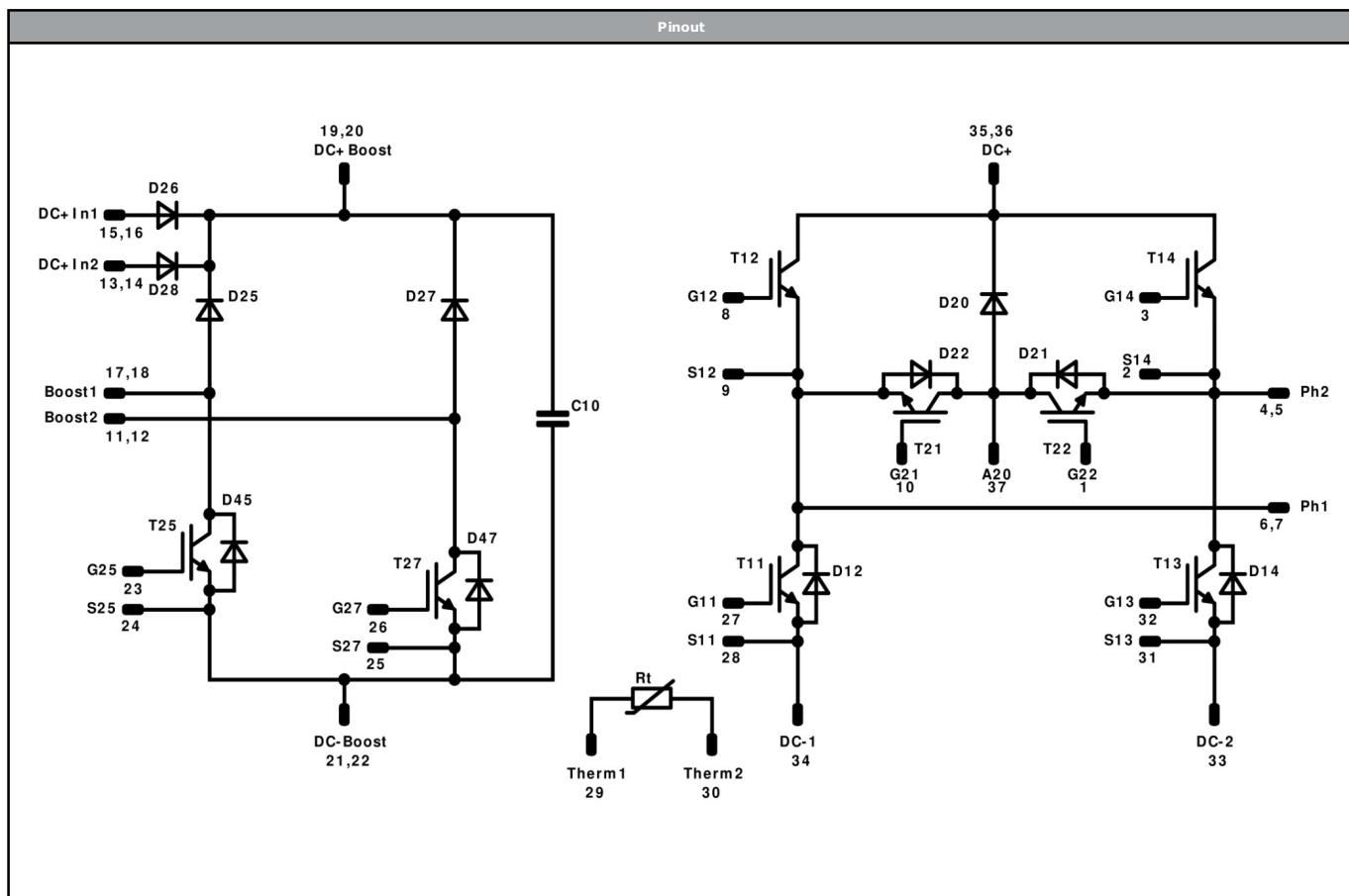
Input Boost Switching Characteristics





**10-FY07BVA050S5-LF44E18
10-PY07BVA050S5-LF44E18Y**
datasheet

Vincotech



Identification					
ID	Component	Voltage	Current	Function	Comment
T11, T13	IGBT	650 V	50 A	Low Buck Switch	
T12, T14	IGBT	650 V	50 A	High Buck Switch	
D21, D22	FWD	650 V	30 A	Buck Diode	
T21, T22	IGBT	650 V	50 A	Boost Switch	
D12, D14	FWD	650 V	30 A	Low Boost Diode	
D20	FWD	650 V	30 A	High Boost Diode	
T25, T27	IGBT	650 V	50 A	Input Boost Switch	
D25, D27	FWD	650 V	50 A	Input Boost Diode	
D26, D28	Rectifier	1600 V	65 A	ByPass Diode	
D45, D47	FWD	650 V	10 A	Input Boost Sw. Protection Diode	
C10	Capacitor	630 V		Capacitor (DC)	
Rt	NTC			Thermistor	



**10-FY07BVA050S5-LF44E18
10-PY07BVA050S5-LF44E18Y**
datasheet

Vincotech

Packaging instruction			
Standard packaging quantity (SPQ) 100	>SPQ	Standard	<SPQ Sample

Handling instruction			
Handling instructions for flow 1 packages see vincotech.com website.			

Package data			
Package data for flow 1 packages see vincotech.com website.			

UL recognition and file number			
This device is certified according to UL 1557 standard, UL file number E192116. For more information see vincotech.com website.			

Document No.:	Date:	Modification:	Pages
10-xY07BVA050S5-LF44E18x-D3-14	13 Mar. 2019	Correction of I_c/I_f values	1,2,3

DISCLAIMER

The information, specifications, procedures, methods and recommendations herein (together "information") are presented by Vincotech to reader in good faith, are believed to be accurate and reliable, but may well be incomplete and/or not applicable to all conditions or situations that may exist or occur. Vincotech reserves the right to make any changes without further notice to any products to improve reliability, function or design. No representation, guarantee or warranty is made to reader as to the accuracy, reliability or completeness of said information or that the application or use of any of the same will avoid hazards, accidents, losses, damages or injury of any kind to persons or property or that the same will not infringe third parties rights or give desired results. It is reader's sole responsibility to test and determine the suitability of the information and the product for reader's intended use.

LIFE SUPPORT POLICY

Vincotech products are not authorised for use as critical components in life support devices or systems without the express written approval of Vincotech.

As used herein:

1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, or (c) whose failure to perform when properly used in accordance with instructions for use provided in labelling can be reasonably expected to result in significant injury to the user.
2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.